

## FEATURES

- Quad I<sup>2</sup>C Adjustable High Efficiency Step Down DC/DC Converters: 2.5A, 2.5A, 1.5A, 1.5A
- Three 300mA LDO Regulators (Two Adjustable)
- DDR Power Solution with V<sub>TT</sub> and VTTR Reference
- Pushbutton ON/OFF Control with System Reset
- Independent Enable Pin-Strap or I<sup>2</sup>C Sequencing
- Programmable Autonomous Power-Down Control
- Dynamic Voltage Scaling
- Power Good and Reset Functions
- Selectable 2.25MHz or 1.12MHz Switching Frequency
- Always Alive 25mA LDO Regulator
- 12μA Standby Current
- Low Profile 40-Lead 6mm × 6mm × 0.75mm QFN Package

## APPLICATIONS

- Supports Freescale i.MX6, ARM Cortex, and Other Application Processors
- Handheld Instruments and Scanners
- Portable Industrial and Medical Devices
- Automotive Infotainment
- High End Consumer Devices
- Multi-Rail Systems

## DESCRIPTION

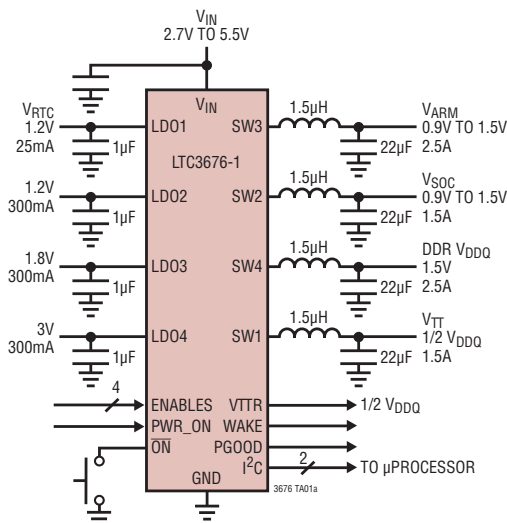
The LTC<sup>®</sup>3676 is a complete power management solution for advanced portable application processor-based systems. The device contains four synchronous step-down DC/DC converters for core, memory, I/O, and system on-chip (SoC) rails and three 300mA LDO regulators for low noise analog supplies. The LTC3676-1 has a ±1.5A buck regulator configured to support DDR termination plus a VTTR reference output. An I<sup>2</sup>C serial port is used to control regulator enables, power-down sequencing, output voltage levels, dynamic voltage scaling, operating modes and status reporting.

Regulator start-up is sequenced by connecting outputs to enable pins in the desired order or via the I<sup>2</sup>C port. System power-on, power-off and reset functions are controlled by pushbutton interface, pin inputs, or I<sup>2</sup>C.

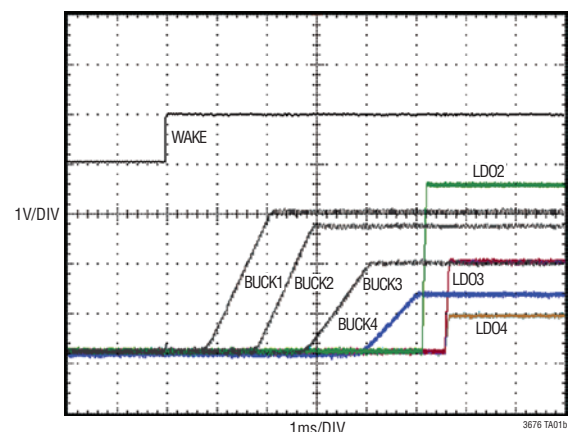
The LTC3676 supports i.MX, PXA and OMAP processors with eight independent rails at appropriate power levels. Other features include interface signals such as the VSTB pin that toggles between programmed run and standby output voltages on up to four rails simultaneously. The device is available in a 40-lead 6mm × 6mm QFN package.

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## TYPICAL APPLICATION



**Start-Up Sequence**



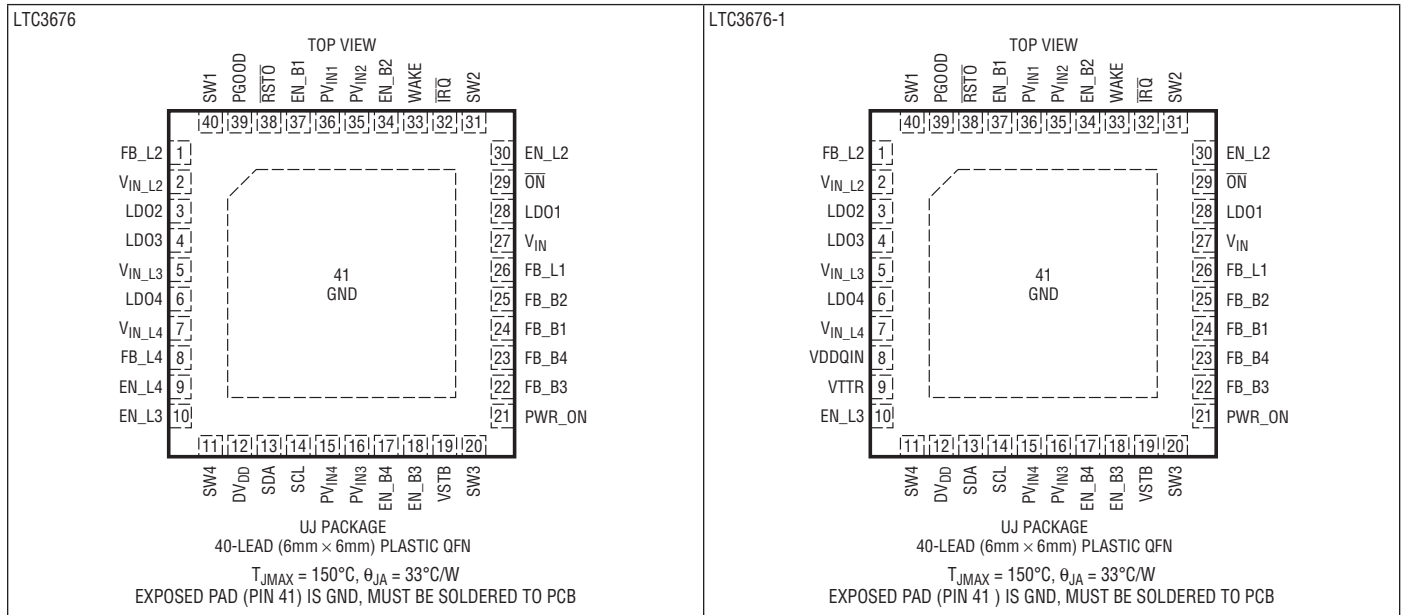
# LTC3676/LTC3676-1

## ABSOLUTE MAXIMUM RATINGS (Note 1)

$V_{IN}$ ,  $DV_{DD}$ , SW1, SW2, SW3, SW4 ..... -0.3V to 6V  
 SW1, SW2, SW3, SW4  
 (Transient  $t < 1\mu s$ , Duty Cycle  $< 5\%$ ) ..... -2V to 7V  
 $PV_{IN1}$ ,  $PV_{IN2}$ ,  $PV_{IN3}$ ,  $PV_{IN4}$ ,  $V_{IN\_L2}$ ,  
 $V_{IN\_L3}$ ,  $V_{IN\_L4}$  ..... -0.3V to  $V_{IN} + 0.3V$   
 LDO1, FB\_L1, LDO2, FB\_L2, LDO3, FB\_L3, LDO4,  
 FB\_L4, FB\_B1, FB\_B2, FB\_B3, FB\_B4, PGOOD,  
 VSTB, EN\_B1, EN\_B2, EN\_B3, EN\_B4, EN\_L2,  
 EN\_L3, EN\_L4,  $\overline{ON}$ , WAKE,  $\overline{RSTO}$ , PWR\_ON,  $\overline{IRQ}$ ,  
 VTTR, VDDQIN ..... -0.3V to 6V

$SDA$ ,  $SCL$  ..... -0.3V to  $DV_{DD} + 0.3V$   
 Operating Junction Temperature Range  
 (Notes 2, 3) ..... -40°C to 150°C  
 Storage Temperature Range ..... -65 to 150°C

## PIN CONFIGURATION



## ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC3676EUJ#PBF	LTC3676EUJ#TRPBF	LTC3676UJ	40-Lead (6mm × 6mm) Plastic QFN	-40°C to 125°C
LTC3676IUJ#PBF	LTC3676IUJ#TRPBF	LTC3676UJ	40-Lead (6mm × 6mm) Plastic QFN	-40°C to 125°C
LTC3676HUJ#PBF	LTC3676HUJ#TRPBF	LTC3676UJ	40-Lead (6mm × 6mm) Plastic QFN	-40°C to 150°C
LTC3676EUJ-1#PBF	LTC3676EUJ-1#TRPBF	LTC3676UJ-1	40-Lead (6mm × 6mm) Plastic QFN	-40°C to 125°C
LTC3676IUJ-1#PBF	LTC3676IUJ-1#TRPBF	LTC3676UJ-1	40-Lead (6mm × 6mm) Plastic QFN	-40°C to 125°C
LTC3676HUJ-1#PBF	LTC3676HUJ-1#TRPBF	LTC3676UJ-1	40-Lead (6mm × 6mm) Plastic QFN	-40°C to 150°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container.

Consult LTC Marketing for information on nonstandard lead based finish parts.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandree/>

**ELECTRICAL CHARACTERISTICS** The ● denotes the specifications which apply over the specified operating junction temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$  (Note 2).  $V_{IN} = PV_{IN1} = PV_{IN2} = PV_{IN3} = PV_{IN4} = V_{IN\_L2} = V_{IN\_L3} = V_{IN\_L4} = DV_{DD} = 3.8\text{V}$ . All regulators disabled unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Operating Input Supply Voltage, $V_{IN}$		●	2.7		5.5	V
$V_{IN}$ Standby Current	PWR_ON = 0V	●		12	21	$\mu\text{A}$
<b>Step-Down Switching Regulators 1, 2, 3 and 4</b>						
Output Voltage Range			$V_{FB}$		$PV_{IN}$	V
Burst Mode <sup>®</sup> $V_{IN}$ Quiescent Current	$V_{FB} = 850\text{mV}$ (Note 5)	●		23	50	$\mu\text{A}$
Pulse-Skipping Mode $V_{IN}$ Quiescent Current		●		120	200	$\mu\text{A}$
Forced Continuous $V_{IN}$ Quiescent Current		●		170	300	$\mu\text{A}$
Feedback Pin Input Current	$V_{FB} = 850\text{mV}$		-0.05		0.05	$\mu\text{A}$
Maximum Duty Cycle	$V_{FB} = 0\text{V}$		100			%
SW Pull-Down Resistance	Regulator Disabled			625		$\Omega$
Feedback Reference Soft-Start Rate	(Note 6)			0.8		V/ms
High Feedback Regulation Voltage ( $V_{FB}$ )	DVBxA[4:0] = DVBxB[4:0] = 11111, $V_{IN} = 2.7\text{V}$ to $5.5\text{V}$	●	788	800	812	mV
Default Feedback Regulation Voltage ( $V_{FB}$ )	DVBxA[4:0] = DVBxB[4:0] = 11001, $V_{IN} = 2.7\text{V}$ to $5.5\text{V}$	●	714	725	736	mV
Low Feedback Regulation Voltage ( $V_{FB}$ )	DVBxA[4:0] = DVBxB[4:0] = 00000, $V_{IN} = 2.7\text{V}$ to $5.5\text{V}$	●	404	412.5	421	mV
Feedback LSB Step Size				12.5		mV
Switching Frequency	BUCKx[2] = 0 BUCKx[2] = 1	● ●	1.7 0.85	2.25 1.125	2.7 1.35	MHz MHz
<b>1.5A Step-Down Switching Regulators 1 and 2</b>						
PMOS Current Limit		●	2			A
PMOS On-Resistance (Note 7)				160		m $\Omega$
NMOS On-Resistance (Note 7)				80		m $\Omega$
<b>2.5A Step-Down Switching Regulators 3 and 4</b>						
PMOS Current Limit		●	3.0			A
PMOS On-Resistance (Note 7)				120		m $\Omega$
NMOS On-Resistance (Note 7)				70		m $\Omega$
<b>Step-Down Switching Regulator 1 and VTTR (LTC3676-1)</b>						
Buck 1 Feedback Regulation Voltage	$V_{DDQIN} = 1.5\text{V}$	●	$VTTR - 10$	$VTTR$	$VTTR + 10$	mV
VTTR Output Voltage	$V_{DDQIN} = 1.5\text{V}$	●	$0.49 \cdot V_{DDQIN}$	$0.5 \cdot V_{DDQIN}$	$0.51 \cdot V_{DDQIN}$	mV
VTTR Maximum Output Current		●	-10		10	mA
$I_{VIN}$ VTTR Enabled				1		mA
<b>LDO Regulators 2, 3 and 4</b>						
Feedback Reference Soft-Start Rate				10		V/ms
Output Pull-Down Resistance	Regulator Disabled			625		$\Omega$
<b>LDO Regulator 1</b>						
Output Voltage Range			$V_{FB\_L1}$		$V_{IN}$	
Feedback Regulation Voltage ( $V_{FB\_L1}$ )		●	689	725	761	mV
Line Regulation	$I_{LDO1} = 1\text{mA}$ , LDO1 = 1.2V, $V_{IN} = 2.7\text{V}$ to $5.5\text{V}$			0.15		%/V
Load Regulation	$I_{LDO1} = 0.1\text{mA}$ to $25\text{mA}$ , LDO1 = 3.3V			0.1		%

# LTC3676/LTC3676-1

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PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Available Output Current		●	25			mA
Short-Circuit Output Current Limit				65	100	mA
Dropout Voltage (Note 4)	$I_{LD01} = 25\text{mA}$ , $V_{LD01} = 3.3\text{V}$			200	280	mV
Feedback Pin Input Current	$V_{FB\_L1} = 850\text{mV}$		-0.05		0.05	$\mu\text{A}$
<b>LDO Regulator 2</b>						
$V_{IN\_LD02}$ Input Voltage		●	1.7		$V_{IN}$	V
LDO2 Output Voltage Range	$I_{LD02} = 1\text{mA}$		$V_{FB\_L2}$		$V_{IN\_L2}$	V
Available Output Current		●	300			mA
$V_{IN\_L2}$ Quiescent Current	Regulator Enabled, $I_{LD02} = 0\text{A}$	●		12	25	$\mu\text{A}$
$V_{IN\_L2}$ Shutdown Current	Regulator Disabled	●		0	1	$\mu\text{A}$
$V_{IN}$ Quiescent Current	Regulator Enabled	●		50	85	$\mu\text{A}$
Feedback Regulation Voltage ( $V_{FB\_L2}$ )		●	0.707	0.725	0.743	V
Line Regulation	$I_{LD02} = 1\text{mA}$ , $V_{IN} = 2.7\text{V}$ to $5.5\text{V}$			0.01		%/V
Load Regulation	$I_{LD02} = 1\text{mA}$ to $300\text{mA}$			0.01		%
Short-Circuit Current Limit					770	mA
Dropout Voltage (Note 4)	$I_{LD02} = 300\text{mA}$ , $V_{LD02} = 2.5\text{V}$ $I_{LD02} = 300\text{mA}$ , $V_{LD02} = 1.2\text{V}$			210 450	260 615	mV mV
Feedback Pin Input Current	$V_{LD02\_FB} = 725\text{mV}$		-0.05		0.05	$\mu\text{A}$
<b>LDO Regulator 3</b>						
$V_{IN\_L3}$ Input Voltage		●	2.35		$V_{IN}$	V
Output Voltage	$V_{IN\_L3} = V_{IN}$ , $I_{LD03} = 1\text{mA}$	●	1.746	1.8	1.854	V
Available Output Current		●	300			mA
$V_{IN\_L3}$ Quiescent Current	Regulator Enabled, $I_{LD03} = 0\text{A}$	●		14	25	$\mu\text{A}$
$V_{IN\_L3}$ Shutdown Current	Regulator Disabled	●		0	1	$\mu\text{A}$
$V_{IN}$ Quiescent Current		●		50	85	$\mu\text{A}$
Line Regulation	$I_{LD03} = 1\text{mA}$ , $V_{IN} = 2.7\text{V}$ to $5.5\text{V}$			0.01		%/V
Load Regulation	$I_{LD03} = 1\text{mA}$ to $300\text{mA}$			0.05		%
Short-Circuit Current Limit					770	mA
Dropout Voltage (Note 4)	$I_{LD03} = 300\text{mA}$ , $V_{LD03} = 1.8\text{V}$			280	350	mV
<b>LDO Regulator 4</b>						
$V_{IN\_L4}$ Input Voltage		●	1.7		$V_{IN}$	V
LDO4 Output Voltage Range (LTC3676)	$I_{LD04} = 1\text{mA}$		$V_{FB\_L4}$		$V_{IN\_L4}$	V
Feedback Regulation Voltage (LTC3676) ( $V_{FB\_L4}$ )		●	0.707	0.725	0.743	V
Output Voltage (LTC3676-1)	$I_{LD04} = 1\text{mA}$ , $LDOB[4:3] = 00$	●	1.164	1.2	1.236	V
	$LDOB[4:3] = 01$	●	2.425	2.5	2.575	V
	$LDOB[4:3] = 10$	●	2.716	2.8	2.884	V
	$LDOB[4:3] = 11$	●	2.91	3.0	3.09	V
Available Output Current		●	300			mA
$V_{IN\_L4}$ Quiescent Current	Regulator Enabled, $I_{LD04} = 0\text{A}$	●		12	25	$\mu\text{A}$
$V_{IN\_L4}$ Shutdown Current	Regulator Disabled	●		0	1	$\mu\text{A}$
$V_{IN}$ Quiescent Current	Regulator Enabled	●		50	85	$\mu\text{A}$
Line Regulation	$I_{LD04} = 1\text{mA}$ , $V_{IN} = 2.7\text{V}$ to $5.5\text{V}$			0.01		%/V

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PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Load Regulation (LTC3676)	$I_{LD04} = 1\text{mA to } 300\text{mA}$			0.01		%
Load Regulation (LTC3676-1)				0.05		%
Short-Circuit Current Limit					770	mA
Dropout Voltage (Note 4)	$I_{LD04} = 300\text{mA}, V_{LD04} = 2.5\text{V}$ $I_{LD04} = 300\text{mA}, V_{LD04} = 1.2\text{V}$			210	260	mV
				450	615	mV
Feedback Pin Input Current (LTC3676)	$V_{LD04\_FB} = 725\text{mV}$		-0.05		0.05	$\mu\text{A}$
<b>Enable Inputs</b>						
Threshold Rising	All Enables Low	●		0.75	1.2	V
Threshold Falling	One Enable High	●	0.4	0.7		
Precision Threshold	One or More Enables	●	0.370	0.400	0.430	V
Input Pull-Down Resistance				4.5		$\text{M}\Omega$
<b>VSTB, PWR_ON Inputs</b>						
Threshold		●	0.370	0.400	0.430	V
Pull-Down Resistance				4.5		$\text{M}\Omega$
<b>Pushbutton Interface</b>						
$\overline{\text{ON}}$ Threshold Rising		●		0.75	1.2	V
$\overline{\text{ON}}$ Threshold Falling		●	0.4	0.7		V
$\overline{\text{ON}}$ Input Current	$\overline{\text{ON}} = V_{IN}$ $\overline{\text{ON}} = 0\text{V}$		-1		1	$\mu\text{A}$
				-40		$\mu\text{A}$
$\overline{\text{ON}}$ Low Time to $\overline{\text{IRQ}}$ Low				50		ms
$\overline{\text{ON}}$ High Time to $\overline{\text{IRQ}}$ High				0.2		$\mu\text{s}$
$\overline{\text{ON}}$ Low Time to WAKE High				400		ms
$\overline{\text{ON}}$ Low Time to Hard Reset	CNTRL[6] = 0			10		sec
$\overline{\text{IRQ}}$ Minimum Pulse Width				50		ms
$\overline{\text{IRQ}}$ Blanking from WAKE Low				1		sec
Minimum WAKE Low Time				1		sec
WAKE High Time with PWR_ON = 0V				5		sec
PWR_ON High to WAKE High				3		ms
PWR_ON Low to WAKE Low				3		ms
<b>Status Output Pins (WAKE, PGOOD, <math>\overline{\text{RSTO}}</math>, <math>\overline{\text{IRQ}}</math>)</b>						
WAKE Output Low Voltage	$I_{WAKE} = 3\text{mA}$			0.1	0.4	V
WAKE Output High Leakage Current	$V_{WAKE} = 3.8\text{V}$		-0.1		0.1	$\mu\text{A}$
PGOOD Output Low Voltage	$I_{PGOOD} = 3\text{mA}$			0.1	0.4	V
PGOOD Output High Leakage Current	$V_{PGOOD} = 3.8\text{V}$		-0.1		0.1	$\mu\text{A}$
PGOOD Threshold Rising				-6		%
PGOOD Threshold Falling				-8		%
$\overline{\text{RSTO}}$ Output Low Voltage	$I_{\overline{\text{RSTO}}} = 3\text{mA}$			0.1	0.4	V
$\overline{\text{RSTO}}$ Output High Leakage Current	$V_{\overline{\text{RSTO}}} = 3.8\text{V}$		-0.1		0.1	$\mu\text{A}$
LD01 Power Good Threshold Rising				-7.5		%
LD01 Power Good Threshold Falling				-10		%
$\overline{\text{IRQ}}$ Output Low Voltage	$I_{\overline{\text{IRQ}}} = 3\text{mA}$			0.1	0.4	V
$\overline{\text{IRQ}}$ Output High Leakage Current	$V_{\overline{\text{IRQ}}} = 3.8\text{V}$		-0.1		0.1	$\mu\text{A}$

# LTC3676/LTC3676-1

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PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Undervoltage Lockout Rising		●	2.55	2.65	V
Undervoltage Lockout Falling		●	2.35	2.45	V
Undervoltage Warning	CNTRL[4:2] = 000 (POR Default)		2.7		V
	CNTRL[4:2] = 001		2.8		V
	CNTRL[4:2] = 010		2.9		V
	CNTRL[4:2] = 011		3.0		V
	CNTRL[4:2] = 100		3.1		V
	CNTRL[4:2] = 101		3.2		V
	CNTRL[4:2] = 110		3.3		V
	CNTRL[4:2] = 111		3.4		V

SYMBOL	PARAMETER	CONDITONS	MIN	TYP	MAX	UNITS
<b>I<sup>2</sup>C Port</b>						
DV <sub>VDD</sub>	DV <sub>VDD</sub> Input Supply Voltage		●	1.6	5.5	V
I <sub>DVDD</sub>	DV <sub>VDD</sub> Quiescent Current	SCL/SDA = 0kHz		0.3	1	μA
DV <sub>VDD_UVLO</sub>	DV <sub>VDD</sub> UVLO Level			1		V
ADDRESS	LTC3676 Device Address LTC3676-1 Device Address			0111100[R/W] 0111101[R/W]		
V <sub>IH</sub>	SDA/SCL Input Threshold Rising			70		%DV <sub>VDD</sub>
V <sub>IL</sub>	SDA/SCL Input Threshold Falling			30		%DV <sub>VDD</sub>
I <sub>IH</sub>	SDA/SCL High Input Current	SDA = SCL = 5.5V	-1	0	1	μA
I <sub>IL</sub>	SDA/SCL Low Input Current	SDA = SCL = 0V	-1	0	1	μA
V <sub>OL_SDA</sub>	SDA Output Low Voltage	I <sub>SDA</sub> = 3mA			0.4	V
f <sub>SCL</sub>	Clock Operating Frequency				400	kHz
t <sub>BUF</sub>	Bus Free Time Between Stop and Start Condition		1.3			μs
t <sub>HD_STA</sub>	Hold Time After Repeated Start Condition		0.6			μs
t <sub>SU_STA</sub>	Repeated Start Condition Setup Time		0.6			μs
t <sub>SU_STO</sub>	Stop Condition Setup Time		0.6			μs
t <sub>HD_DAT(O)</sub>	Data Hold Time Output		0		900	ns
t <sub>HD_DAT(I)</sub>	Data Hold Time Input		0			ns
t <sub>SU_DAT</sub>	Data Setup Time		100			ns
t <sub>LOW</sub>	SCL Clock Low Period		1.3			μs
t <sub>HIGH</sub>	SCL Clock High Period		0.6			μs
t <sub>f</sub>	Clock/Data Fall Time	C <sub>B</sub> = Capacitance of BUS Line (pF)	20 + 0.1C <sub>B</sub>		300	ns
t <sub>r</sub>	Clock/Data Rise Time	C <sub>B</sub> = Capacitance of BUS Line (pF)	20 + 0.1C <sub>B</sub>		300	ns
t <sub>SP</sub>	Input Spike Suppression Pulse Width				50	ns

**Note 1:** Stresses beyond those listed Under Absolute Maximum ratings may cause permanent damage to the device. Exposure to any Absolute Maximum rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** The LTC3676 is tested under pulsed load conditions such that  $T_J \approx T_A$ . The LTC3676E is guaranteed to meet specifications from  $0^\circ\text{C}$  to  $85^\circ\text{C}$  junction temperature. Specifications over the  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  operating junction temperature range are assured by design, characterization and correlation with statistical process controls. The LTC3676I is guaranteed over the  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  operating junction temperature range and the LTC3676H is guaranteed over the full  $-40^\circ\text{C}$  to  $150^\circ\text{C}$  operating junction temperature range. High junction temperatures

degrade operating lifetimes; operating lifetime is derated for junction temperatures greater than  $125^\circ\text{C}$ . The junction temperature ( $T_J$  in  $^\circ\text{C}$ ) is calculated from the ambient temperature ( $T_A$  in  $^\circ\text{C}$ ) and power dissipation ( $P_D$ , in Watts), and package to junction ambient thermal impedance ( $\theta_{JA}$  in  $\text{Watts}/^\circ\text{C}$ ) according to the formula:

$$T_J = T_A + (P_D \cdot \theta_{JA}).$$

Note that the maximum ambient temperature consistent with these specifications is determined by specific operating conditions in conjunction with board layout, the rated package thermal impedance and other environmental factors.

## ELECTRICAL CHARACTERISTICS

**Note 3:** The LTC3676 includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed 150°C when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

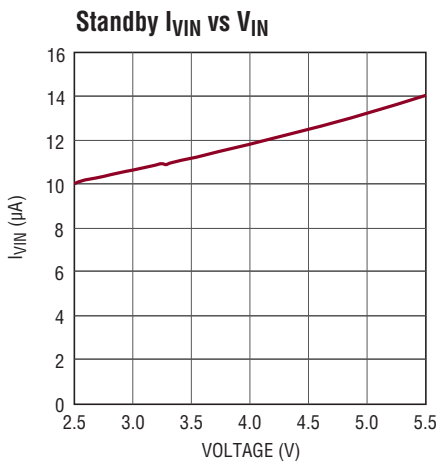
**Note 4:** Dropout voltage is defined as  $(V_{IN} - V_{LDO1})$  for LDO1 or  $(V_{IN\_Lx} - V_{LDOx})$  for other LDOs when  $V_{LDOx}$  is 3% lower than  $V_{LDOx}$  measured with  $V_{IN} = V_{IN\_Lx} = 4.3V$ .

**Note 5:** Dynamic supply current is higher due to the gate charge being delivered at the switching frequency.

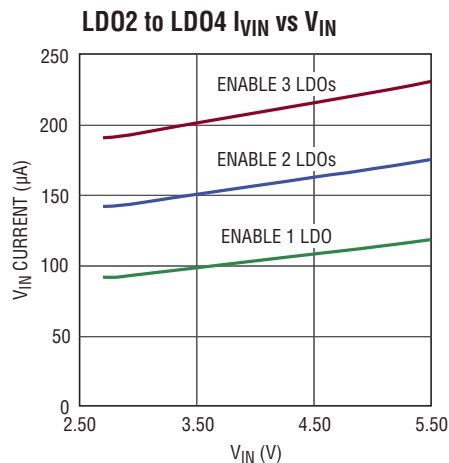
**Note 6:** Soft-Start measured in test mode with regulator error amplifier in unity-gain mode.

**Note 7:** The switching regulator PMOS and NMOS on-resistance is guaranteed by correlation to wafer level measurements.

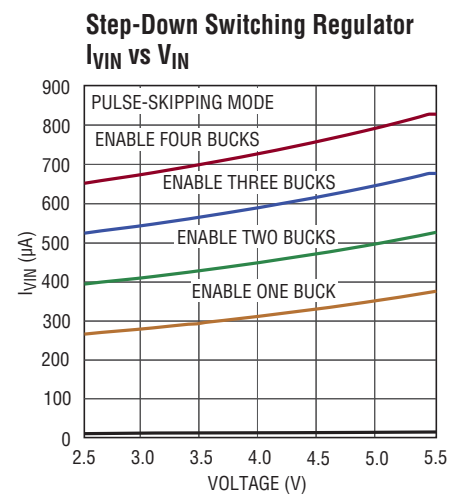
## TYPICAL PERFORMANCE CHARACTERISTICS $V_{IN} = 3.8V, T_A = 25^\circ C$ unless otherwise noted



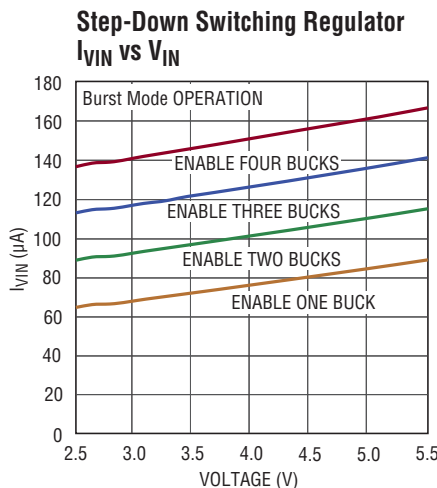
3676 G01



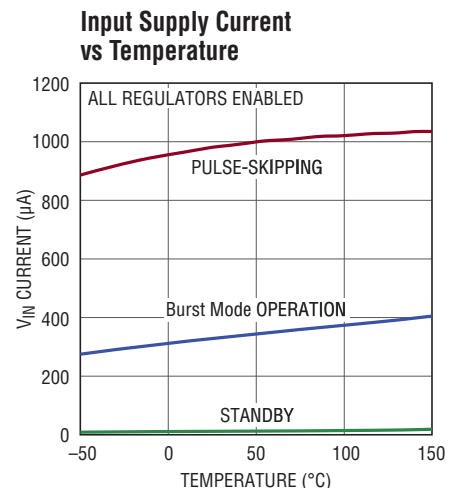
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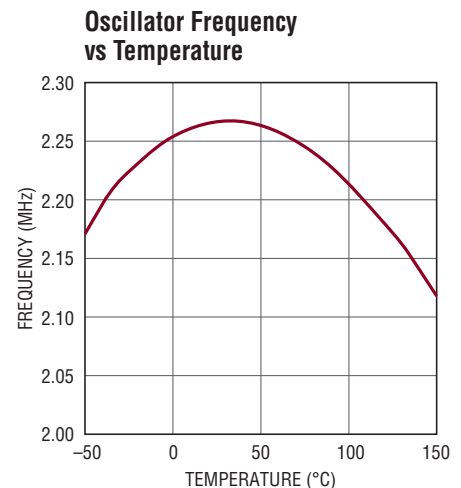
3676 G03



3676 G04



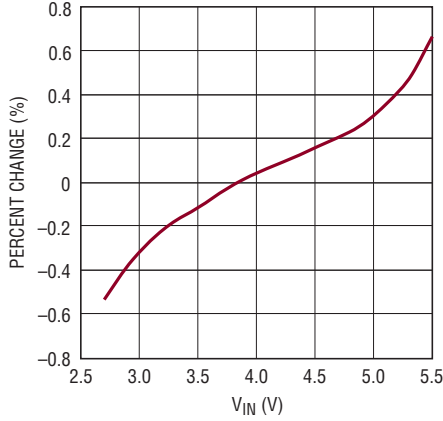
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3676 G06

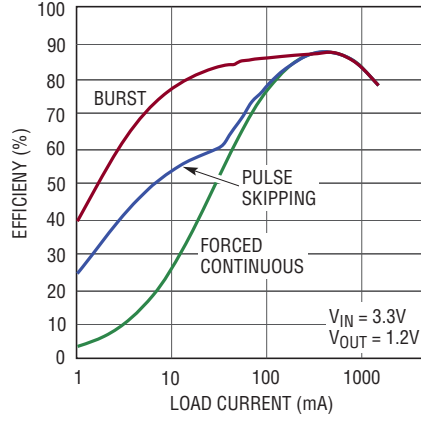
## TYPICAL PERFORMANCE CHARACTERISTICS

**Oscillator Frequency Change vs  $V_{IN}$**



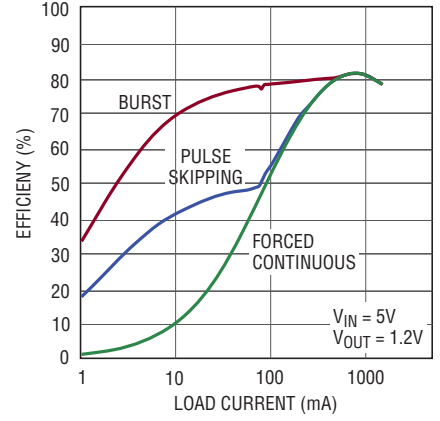
3676 G07

**Step-Down Switching Regulators 1 and 2 Efficiency vs  $I_{OUT}$**



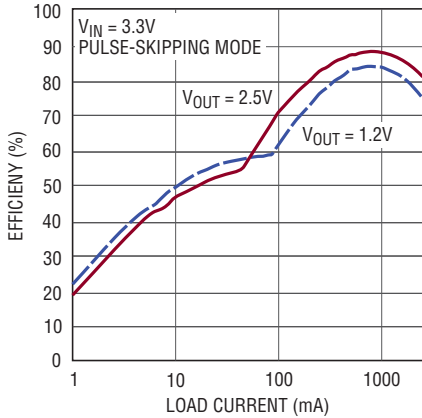
3676 G08

**Step-Down Switching Regulators 1 and 2 Efficiency vs  $I_{OUT}$**



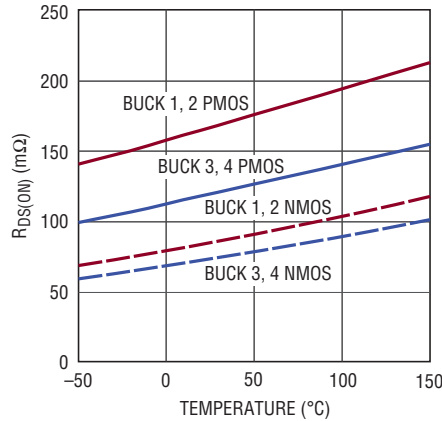
3676 G09

**Step-Down Switching Regulators 3 and 4 Efficiency vs  $I_{OUT}$**



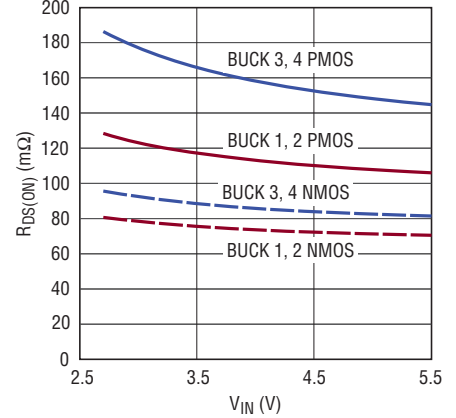
3676 G10

**Buck  $R_{DS(ON)}$  vs Temperature**



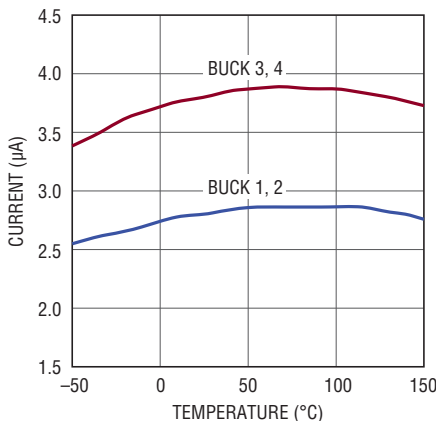
3676 G11

**Buck  $R_{DS(ON)}$  vs  $V_{IN}$**



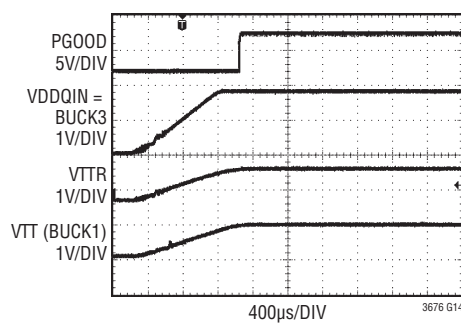
3676 G12

**Step-Down Switching Regulator Current Limit vs Temperature**



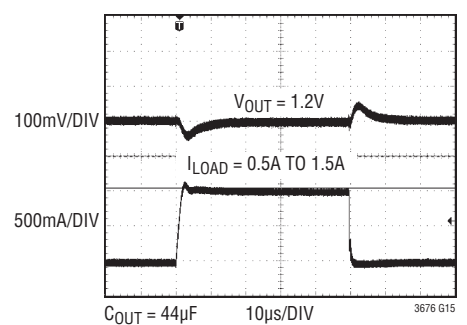
3676 G13

**LTC3676-1  $V_{DDQIN}$ ,  $V_{TRR}$  and  $V_{TT}$  Start-Up**



3676 G14

**Step-Down Switching Regulator Load Step**

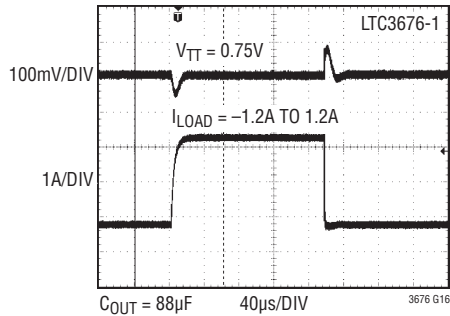


3676 G15

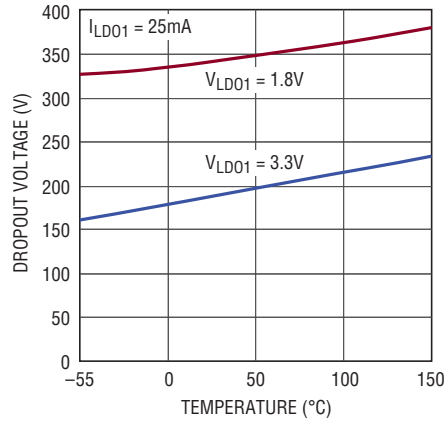


# TYPICAL PERFORMANCE CHARACTERISTICS

LTC3676-1  $V_{TT}$  Load Step

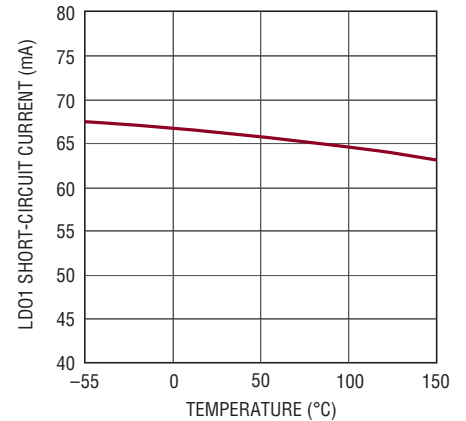


LD01 Dropout Voltage vs Temperature



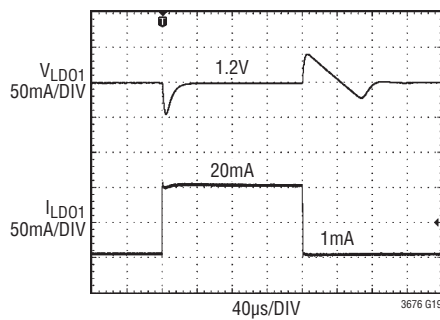
3676 G17

LD01 Short-Circuit Current vs Temperature

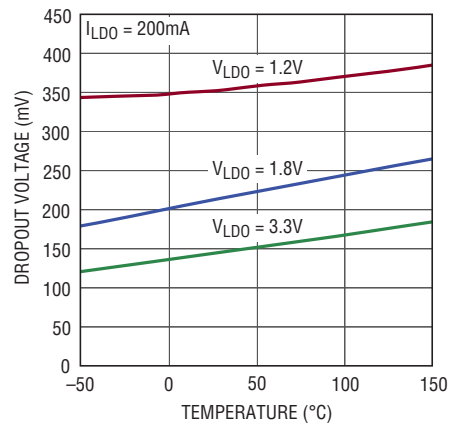


3676 G18

LD01 Load Step Response

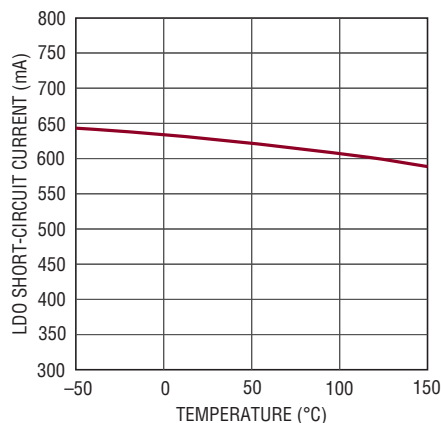


LD02 to LD04 Dropout Voltage vs Temperature



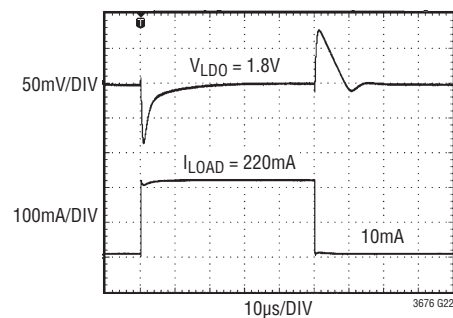
3676 G20

LD02 to LD04 Short-Circuit Current vs Temperature



3676 G21

LD02 to LD04 Load Step Response



## PIN FUNCTIONS

**FB\_L2 (Pin 1):** Feedback Input for LDO2. Set full-scale output voltage using a resistor divider connected from LDO2 to this pin to ground.

**V<sub>IN\_L2</sub> (Pin 2):** Power Input for LDO2. This pin should be bypassed to ground with a 1 $\mu$ F or greater ceramic capacitor. Voltage on V<sub>IN\_L2</sub> should not exceed voltage on V<sub>IN</sub> pin.

**LDO2 (Pin 3):** Output Voltage of LDO2. Nominal output voltage is set with a resistor feedback divider that servos to a fixed 725mV reference. This pin must be bypassed to ground with a 1 $\mu$ F or greater ceramic capacitor.

**LDO3 (Pin 4):** Output Voltage of LDO3. Nominal output voltage is a fixed 1.8V. This pin must be bypassed to ground with a 1 $\mu$ F or greater ceramic capacitor.

**V<sub>IN\_L3</sub> (Pin 5):** Power Input for LDO3. This pin should be bypassed to ground with a 1 $\mu$ F or greater ceramic capacitor. Voltage on V<sub>IN\_L3</sub> should not exceed voltage on V<sub>IN</sub> pin.

**LDO4 (Pin 6):** Output Voltage of LDO4. Nominal output voltage is set with a resistor feedback divider that servos to a fixed 725mV reference. This pin must be bypassed to ground with a 1 $\mu$ F or greater ceramic capacitor.

**V<sub>IN\_L4</sub> (Pin 7):** Power Input for LDO4. This pin should be bypassed to ground with a 1 $\mu$ F or greater ceramic capacitor. Voltage on V<sub>IN\_L4</sub> should not exceed voltage on V<sub>IN</sub> pin.

**FB\_L4 (Pin 8):** Feedback Input for LTC3676 LDO4. Set full-scale output voltage using a resistor divider connected from LDO4 to this pin to ground.

**VDDQIN (Pin 8):** V<sub>DD</sub> Sense Input for LTC3676-1. Tie DDR memory V<sub>DD</sub> supply to this pin.

**EN\_L4 (Pin 9):** Enable LDO4 Input for LTC3676. Active high enables LDO4. A weak pull-down pulls EN\_L4 low when left floating.

**VTR (Pin 9):** DDR V<sub>REF</sub> Output Pin for LTC3676-1. Buffered reference equal to one-half VDDQIN voltage on Pin 8.

**EN\_L3 (Pin 10):** Enable LDO3 Input. Active high enables LDO3. A weak pull-down pulls EN\_L3 low when left floating.

**SW4 (Pin 11):** Switch Pin for Step-Down Switching Regulator 4. Connect one side of step-down switching regulator 4 inductor to this pin.

**DV<sub>DD</sub> (Pin 12):** Supply Voltage for I<sup>2</sup>C Serial Port. This pin sets the logic reference level of SCL and SDA I<sup>2</sup>C pins. DV<sub>DD</sub> resets I<sup>2</sup>C registers to power-on state when driven to <1V. SCL and SDA logic levels are scaled to DV<sub>DD</sub>. Connect a 0.1 $\mu$ F decoupling capacitor from this pin to ground.

**SDA (Pin 13):** Data Pin for the I<sup>2</sup>C Serial Port. The I<sup>2</sup>C logic levels are scaled with respect to DV<sub>DD</sub>.

**SCL (Pin 14):** Clock Pin for the I<sup>2</sup>C Serial Port. The I<sup>2</sup>C logic levels are scaled with respect to DV<sub>DD</sub>.

**PV<sub>IN4</sub> (Pin 15):** Power Input for Step-Down Switching Regulator 4. Tie this pin to V<sub>IN</sub> supply. This pin should be bypassed to ground with a 10 $\mu$ F or greater ceramic capacitor.

**PV<sub>IN3</sub> (Pin 16):** Power Input for Step-Down Switching Regulator 3. Tie this pin to the V<sub>IN</sub> supply. This pin should be bypassed to ground with a 10 $\mu$ F or greater ceramic capacitor.

**EN\_B4 (Pin 17):** Enable Step-Down Switching Regulator 4. Active high input enables step-down switching regulator 4. A weak pull-down pulls EN\_B4 low when left floating.

**EN\_B3 (Pin 18):** Enable Step-Down Switching Regulator 3. Active high input enables step-down switching regulator 3. A weak pull-down pulls EN\_B3 low when left floating.

**VSTB (Pin 19):** Voltage Standby. When VSTB is low, the DAC registers are selected by command register bit DVbxA[5]. When VSTB is high, the DAC registers are forced to DVbxB registers. Tie VSTB to ground if unused.

**SW3 (Pin 20):** Switch Pin for Step-Down Switching Regulator 3. Connect one side of step-down switching regulator 3 inductor to this pin.

**PWR\_ON (Pin 21):** External Power On. Handshaking pin to acknowledge successful power-on sequence. PWR\_ON must be driven high within five seconds of WAKE going high to keep power on. PWR\_ON can be used to activate the WAKE output by driving high. Drive low to shut down WAKE.

**FB\_B3 (Pin 22):** Feedback Input for Step-Down Switching Regulator 3. Set full-scale output voltage using resistor divider connected from the output of step-down switching regulator 3 to this pin to ground.

## PIN FUNCTIONS

**FB\_B4 (Pin 23):** Feedback Input for Step-Down Switching Regulator 4. Set full-scale output voltage using resistor divider connected from the output of step-down switching regulator 4 to this pin to ground.

**FB\_B1 (Pin 24):** Feedback Input for Step-Down Switching Regulator 1. Set full-scale output voltage using resistor divider connected from the output of step-down switching regulator 1 to this pin to ground.

**FB\_B2 (Pin 25):** Feedback Input for Step-Down Switching Regulator 2. Set full-scale output voltage using resistor divider connected from the output of step-down switching regulator 2 to this pin to ground.

**FB\_L1 (Pin 26):** Feedback Input for LDO1. Set output voltage using a resistor divider connected from LDO1 to this pin to ground.

**V<sub>IN</sub> (Pin 27):** Supply Voltage Input. This pin should be bypassed to ground with a 1 $\mu$ F or greater ceramic capacitor. All switching regulator PV<sub>IN</sub> supplies should be tied to V<sub>IN</sub>.

**LDO1 (Pin 28):** Always On LDO1 Output. This pin provides an always-on supply voltage useful for light loads such as a watchdog microprocessor or a real time clock. Connect a 1 $\mu$ F capacitor from LDO1 to ground.

**$\overline{\text{ON}}$  (Pin 29):** Pushbutton Input. A weak internal pull-up forces  $\overline{\text{ON}}$  high when left floating. A normally open pushbutton is connected from  $\overline{\text{ON}}$  to ground forcing a low state when pushed.

**EN\_L2 (Pin 30):** Enable LDO2 Input. Active high enables LDO2. A weak pull-down pulls EN\_L2 low when left floating.

**SW2 (Pin 31):** Switch Pin for Step-Down Switching Regulator 2. Connect one side of step-down switching regulator 2 inductor to this pin.

**$\overline{\text{IRQ}}$  (Pin 32):** Interrupt Request Output. Open-drain driver is pulled low for power good, undervoltage, and overtemperature warning and fault conditions. Clear  $\overline{\text{IRQ}}$  by writing to the I<sup>2</sup>C CLIRQ command register.

**WAKE (Pin 33):** System Wake Up. Open-drain driver output releases high when signaled by pushbutton activation or PWR\_ON input. It may be used to initiate a pin-strapped power-up sequence by connecting to a regulator enable pin.

**EN\_B2 (Pin 34):** Enable Step-Down Switching Regulator 2. Active high input enables step-down switching regulator 2. A weak pull-down pulls EN\_B2 low when left floating.

**PV<sub>IN2</sub> (Pin 35):** Power Input for Step-Down Switching Regulator 2. Tie this pin to V<sub>IN</sub> supply. This pin should be bypassed to ground with a 10 $\mu$ F or greater ceramic capacitor.

**PV<sub>IN1</sub> (Pin 36):** Power Input for Step-Down Switching Regulator 1. Tie this pin to V<sub>IN</sub> supply. This pin should be bypassed to ground with a 10 $\mu$ F or greater ceramic capacitor.

**EN\_B1 (Pin 37):** Enable Step-Down Switching Regulator 1. Active high enables step-down switching regulator 1. A weak pull-down pulls EN\_B1 low when left floating.

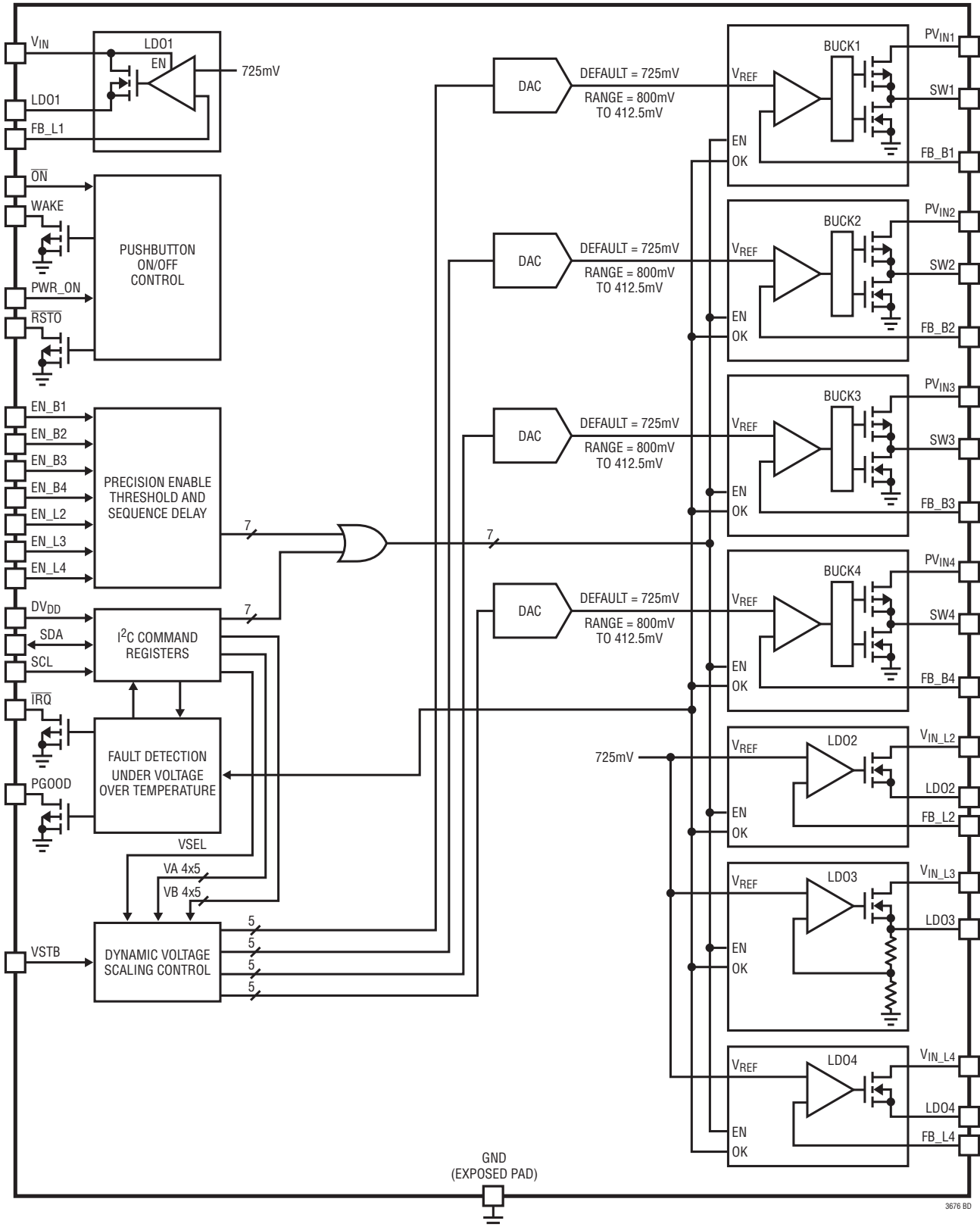
**$\overline{\text{RSTO}}$  (Pin 38):** Reset Output. Open-drain output pulls low when the always-on regulator LDO1 is below regulation or during a hard reset initiated by a pushbutton input or command registers.

**PGOOD (Pin 39):** Power Good Output. Open-drain output pulls low when any enabled regulator falls below power good threshold or during dynamic voltage slew unless disabled in command register. Pulls low when all regulators are disabled.

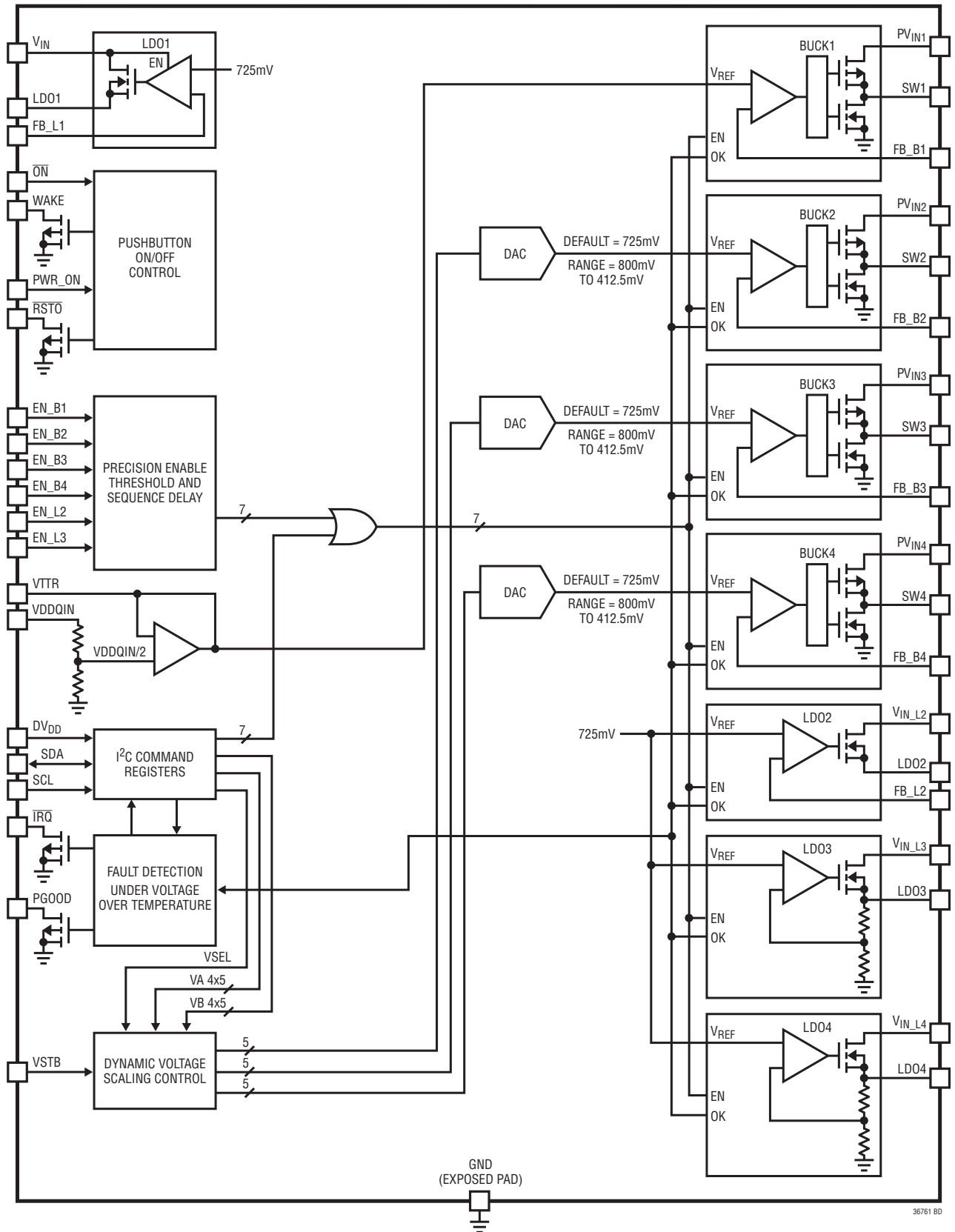
**SW1 (Pin 40):** Switch Pin for Step-Down Switching Regulator 1. Connect one side of step-down switching regulator 1 inductor to this pin.

**GND (Exposed Pad Pin 41):** Ground. The exposed pad must be connected to a continuous ground plane of the printed circuit board by multiple interconnect vias directly under the LTC3676 to maximize electrical and thermal conduction.

## BLOCK DIAGRAM—LTC3676



**BLOCK DIAGRAM—LTC3676-1**



36761 BD

## OPERATION

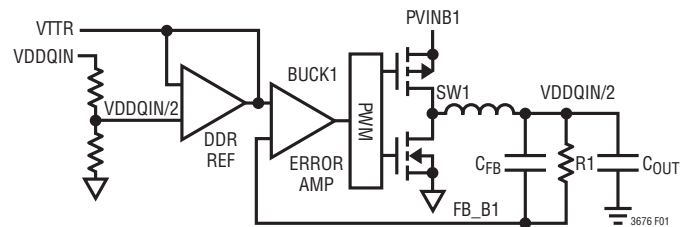
### INTRODUCTION

The LTC3676 is a complete power management solution for portable microprocessors and peripheral devices. It generates a total of eight voltage rails for supplying power to the processor core, DDR memory, I/O, always-on real-time clock and HDD functions. Supplying the voltage rails are an always-on low quiescent current 25mA LDO, two 2.5A step-down regulators, two 1.5A step-down regulators, and three 300mA low dropout regulators. Supporting the multiple regulators is a highly configurable power-on sequencing capability, dynamic voltage scaling DAC output voltage control, a pushbutton interface controller, control via an I<sup>2</sup>C interface, and extensive status and interrupt outputs.

The LTC3676-1 supports DDR memory applications by replacing the LTC3676 LDO4 feedback and enable pins with VTTQIN and VTTR pins. The DDR V<sub>DD</sub> supply is connected to the LTC3676 VDDQIN pin. A buffered DDR termination voltage equal to one half the voltage on VDDQIN is output on VTTR. The VTTR voltage is connected internally on the LTC3676-1 to the reference side of the Buck1 error amplifier. When Buck1 is configured with a gain of one, its output can be used as at DDR termination supply. Table 1 shows the functional differences between the LTC3676 and LTC3676-1.

**Table 1. Functional Differences LTC3676 vs LTC3676-1**

	LTC3676	LTC3676-1
Buck1 Default Frequency	2.25MHz	1.125MHz
Buck1 Default Mode	Pulse-Skipping	Forced Continuous
Buck1 Output	External Resistor Divider. Slewing DAC Reference	External Unity Gain. VTTR Reference
LDO4 Enable	EN_L4 Pin or I <sup>2</sup> C	I <sup>2</sup> C
LDO4 Output	External Resistor Divider. 725mV Reference	I <sup>2</sup> C Select 1 of 4 Fixed Outputs
FB_L4 Pin	External Resistor Divider	—
EN_L4 Pin	Enable LDO4.	—
VDDQIN Pin	—	Connect to DDR Memory Supply
VTTR Pin	—	Buffered Output Equals One-Half VDDQIN
I <sup>2</sup> C Device Address	Write = 0x78 Read = 0x79	Write = 0x7A Read = 0x7B



**Figure 1. V<sub>TT</sub> Buck Regulator and VTTR Reference Block Diagram**

### Always-On 25mA Low Dropout Regulator

The LTC3676 includes a low quiescent current low dropout regulator that remains powered whenever a valid supply is present on V<sub>IN</sub>. The always-on LDO1 remains active until V<sub>IN</sub> drops below 2.0V (typical). This is below the 2.5V undervoltage threshold in effect for the rest of the LTC3676 circuits. The always-on LDO is used to provide power to a standby microcontroller, real-time clock, or other keep-alive circuits. The LDO is guaranteed to support a 25mA load. A 1μF low impedance ceramic bypass capacitor from LDO1 to GND is required for compensation. A power good monitor pulls  $\overline{RSTO}$  low whenever LDO1 is 8% below its regulation target. LDO1 has current limit circuitry to protect from short circuit and overloading. The output voltage of LDO1 is set with a resistor divider connected from LDO1 output pin to the feedback pin FB\_L1, as shown in Figure 2. The output voltage is calculated using the following formula:

$$V_{LDO1} = 725 \cdot \left( 1 + \frac{R1}{R2} \right) \text{ (mV)}$$

### 300mA Low Dropout Regulators

Three LDO regulators on the LTC3676 will each deliver up to 300mA output. Each LDO regulator has separate input supply to help manage power loss in the LDO output devices. The LDO regulators are enabled by pin input or I<sup>2</sup>C command register. When disabled, the regulator outputs are pulled to ground through a 625Ω resistor. A low ESR 1μF ceramic capacitor should be tied from the LDO output to ground. The 300mA LDO regulators have current limit control circuits. The LDO input voltages, V<sub>IN\_L2</sub>, V<sub>IN\_L3</sub>, and V<sub>IN\_L4</sub> must be at potential of V<sub>IN</sub> or less.

The LDO regulator I<sup>2</sup>C command register controls are shown in Table 2 and Table 3.

## OPERATION

### LTC3676 Resistor Programmable LDO2 and LDO4

LDO2 and LDO4 output voltages are programmed by resistor dividers tied from the LDO output pin to the feedback pin as shown in Figure 2. The output voltage is calculated using the following formula:

$$V_{LDO} = 725 \cdot \left( 1 + \frac{R1}{R2} \right) \text{ (mV)}$$

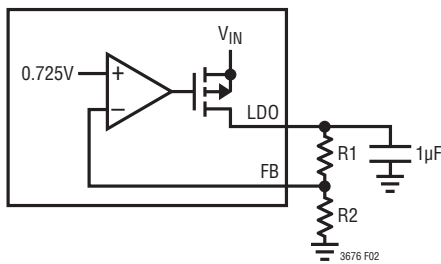


Figure 2. LDO1, LDO2 and LDO4 Application Circuit

### Fixed Output LDO3

Regulator LDO3 has a fixed voltage output of 1.8V.

Table 2. LDO2 and LDO3 Control Command Register Settings

COMMAND REGISTER[BIT]	VALUE	SETTING
LDOA[0]	0* 1	Do Not Keep Alive LDO2 in Standby Keep Alive LDO2 in Standby
LDOA[1]	0* 1	Enable LDO2 at Any Output Voltage Enable LDO2 Only if Output Voltage is <300mV
LDOA[2]	0* 1	LDO2 Disabled if EN_L2 is Low LDO2 Enable
LDOA[3]	0* 1	Do Not Keep Alive LDO3 in Standby Keep Alive LDO3 in Standby
LDOA[4]	0* 1	Enable LDO3 at Any Output Voltage Enable LDO3 Only if Output Voltage is <300mV
LDOA[5]	0* 1	LDO3 Disabled if EN_L3 is Low LDO3 Enabled

\*denotes default power-on value.

### LDO4 Operation LTC3676-1

LDO4 on the LTC3676-1 has neither enable nor feedback pins. There are four LDO4 output voltages selectable by command register bits LDOB[4:3]. The power-on default output is 1.2V with selectable outputs of 2.5V, 2.8V, and 3.0V. LDO4 is enabled only through the command register bit LDOB[2].

### LDO4 Command Register Controls

Table 3. LDO4 Control Command Register Settings

COMMAND REGISTER[BIT]	VALUE	SETTING
LDOB[0]	0* 1	Do Not Keep Alive LDO4 in Standby Keep Alive LDO4 in Standby
LDOB[1]	0* 1	Enable LDO4 at Any Output Voltage Enable LDO4 Only if Output Voltage is <300mV
LDOB[2] (LTC3676)	0* 1	LDO4 Disabled if EN_L4 is Low LDO4 Enabled
LDOB[2] (LTC3676-1)	0* 1	LDO4 Disabled LDO4 Enabled
LDOB[4:3] (LTC3676-1)	00*	LDO4 Output = 1.2V
LDOB[4:3] (LTC3676-1)	01	LDO4 Output = 2.5V
LDOB[4:3] (LTC3676-1)	10	LDO4 Output = 2.8V
LDOB[4:3] (LTC3676-1)	11	LDO4 Output = 3V

\*denotes default power-on value.

### STEP-DOWN SWITCHING REGULATORS

The LTC3676 contains four buck regulators. Two of the buck regulators are capable of delivering up to 2.5A load current and the other two can deliver up to 1.5A each. The regulators have forward and reverse current limiting, soft-start, and switch slew rate control for lower radiated EMI.

The LTC3676 buck regulators are capable of 100% duty cycle, or dropout, regulation. When in dropout the regulator output voltage is equal to  $PV_{IN}$  minus the load current times  $R_{DS(ON)}$  of the converters PMOS device and inductor DCR.

## OPERATION

Each buck regulator is enabled using its enable pin or I<sup>2</sup>C command register control. Operating modes, start-up option, reference voltage, and switch slew rate are controlled using the I<sup>2</sup>C port.

The buck converter I<sup>2</sup>C command register controls are shown in Table 4, Table 5, Table 6, and Table 7.

### Operating Modes

The buck regulators can operate in either pulse-skipping, Burst Mode operation, or forced continuous mode. In pulse-skipping setting the regulator will skip pulses at light loads but will operate at constant frequency. In Burst Mode setting the regulator operates in Burst Mode operation at light loads and in constant frequency PWM mode at higher load. In forced continuous setting the inductor current is allowed to be less than zero over the full range of duty cycles. In forced continuous operation the buck regulator has the ability to sink output current. Because the regulator is switching every cycle regardless of output load, forced continuous mode results in the least output voltage ripple at light load.

### Output Voltage Programming

Each of the step-down converters uses a dynamically slewing DAC for its reference. The output voltage of the DAC reference is selectable using a 5-bit I<sup>2</sup>C command register. The output voltage is set by using a resistor divider connected from the step-down switching regulator output to its feedback pin as shown in Figure 3. The output voltage is calculated using the following formula:

$$V_{OUT} = \left(1 + \frac{R1}{R2}\right) \cdot (DVBx \cdot 12.5 + 412.5) \text{ (mV)}$$

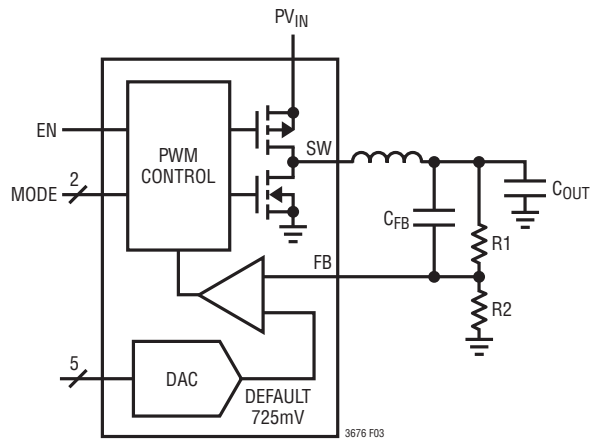


Figure 3. Step-Down Switching Regulator Application Circuit

DVBx is the decimal value of the 5-bit binary number in the I<sup>2</sup>C command registers. The default DAC input code is 11001 (25 in decimal) which corresponds to a reference voltage of 725mV. Typical values for R1 are in the range of 40k to 1M. Capacitor C<sub>FB</sub> cancels the pole created by the feedback resistors and the input capacitance on the FB pin and helps to improve load step transient response. A value of 10pF is recommended for most applications. Experimentation with capacitor sizes between 10pF and 33pF may yield improved transient response.

### Inductor Selection

The choice of step-down switching regulator inductor influences the efficiency and output voltage ripple of the converter. A larger inductor improves efficiency since the peak current is closer to the average output current. Larger inductors generally have higher series resistance that counters the efficiency advantage of reduced peak current.



## OPERATION

Inductor ripple current is a function of switching frequency, inductance,  $V_{IN}$ , and  $V_{OUT}$  as shown in this equation:

$$\Delta I_L = \frac{1}{f \cdot L} \cdot V_{OUT} \cdot \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

A good starting design point is to use an inductor that gives ripple equal to 30% output current. Select an inductor with a DC current rating at least 1.5 times larger than the maximum load current to ensure the inductor does not saturate.

### Input and Output Capacitor Selection

Low ESR ceramic capacitors should be used at both the output and input supply of the switching regulators. Only X5R or X7R ceramic capacitors should be used since they have better temperature and voltage stability than other ceramic types.

### Operating Frequency

The switching frequency of each of the LTC3676 switching regulators may be set using the I<sup>2</sup>C command registers. The default switching frequency is 2.25MHz and the selectable frequency is 1.125MHz. Operation at lower frequency improves efficiency by reducing internal gate charge and switching losses at the expense of a larger inductor.

The lowest duty cycle of the step-down converter is determined by minimum on-time. Minimum on-time is the shortest time duration that the converter can turn its top PMOS on and off again. The time is the sum of gate charge time plus internal delays of the peak current sense and PWM control. If the converters duty cycle will be 20% or less at 2.25MHz it is recommended to use the 1.125MHz setting to avoid minimum duty cycle. If the duty cycle falls

below the minimum on-time of the converter, the output voltage ripple will increase as the converter skips cycles.

The default setting for the LTC3676-1 Buck1 switching frequency is 1.125MHz to ensure minimum on time effects are avoided at DDR termination reference voltages.

### Phase Selection

To reduce the cycle by cycle peak current drawn by the switching regulators, the clock phase at which each of the LTC3676 buck's PMOS switch turns on can be set using I<sup>2</sup>C command register settings.

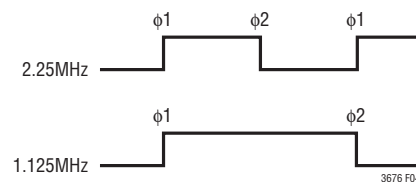


Figure 4. Phase Settings Full- and Half-Speed Buck Clock

### Switch Slew Rate Control

To help reduce EMI the switch rise time of each buck regulator is slew limited by default. A faster setting is selectable using the I<sup>2</sup>C buck command registers. The faster setting will improve efficiency if limited edge rate is not required.

### Soft-Start

To reduce inrush current at start-up each buck regulator soft starts when enabled. When enabled the internal reference voltage is ramped from ground to the level of the slewing DAC output at a rate of 0.8V/ms. During soft-start the converter is forced to pulse-skipping mode regardless of command register mode settings.

## OPERATION

**Table 4. Buck1 Control Command Register**

COMMAND REGISTER[BIT]	VALUE	SETTING
BUCK1[0]	0* 1	Switch Slew Rate Normal Switch Slew Rate Fast
BUCK1[1]	0* 1	Do Not Keep Enabled in Device Standby Keep Enabled in Device Standby
BUCK1[2] (LTC3676)	0* 1	Switching Frequency 2.25MHz Switching Frequency 1.125MHz
BUCK1[2] (LTC3676-1)	0* 1	Switching Frequency 1.125MHz Switching Frequency 2.25MHz
BUCK1[3]	0* 1	Clock Phase 1 Clock Phase 2
BUCK1[4]	0* 1	Enable at Any Output Voltage Enable Only if Output Voltage Is <300mV
BUCK1[6:5]	00* 01 10	Pulse-Skipping Mode Burst Mode Operation Forced Continuous Mode
BUCK1[7]	0* 1	Buck1 Disabled if EN_B1 Pin Is Low Buck1 Enabled

\*denotes default power on-value.

**Table 5. Buck2 Control Command Register**

COMMAND REGISTER[BIT]	VALUE	SETTING
BUCK2[0]	0* 1	Switch Slew Rate Normal Switch Slew Rate Fast
BUCK2[1]	0* 1	Do Not Keep Enabled in Device Standby Keep Enabled in Device Standby
BUCK2[2]	0* 1	Switching Frequency 2.25MHz Switching Frequency 1.125MHz
BUCK2[3]	0* 1	Clock Phase 1 Clock Phase 2
BUCK2[4]	0* 1	Enable at Any Output Voltage Enable Only if Output Voltage Is <300mV
BUCK2[6:5]	00* 01 10	Pulse-Skipping Mode Burst Mode Operation Forced Continuous Mode
BUCK2[7]	0* 1	Buck2 Disabled if EN_B2 Pin Is Low Buck2 Enabled

\*denotes default power-on value.

**Table 6. Buck3 Control Command Register**

COMMAND REGISTER[BIT]	VALUE	SETTING
BUCK3[0]	0* 1	Switch Slew Rate Normal Switch Slew Rate Fast
BUCK3[1]	0* 1	Do Not Keep Enabled in Device Standby Keep Enabled in Device Standby
BUCK3[2]	0* 1	Switching Frequency 2.25MHz Switching Frequency 1.125MHz
BUCK3[3]	0* 1	Clock Phase 1 Clock Phase 2
BUCK3[4]	0* 1	Enable at Any Output Voltage Enable Only if Output Voltage Is <300mV
BUCK3[6:5]	00* 01 10	Pulse-Skipping Mode Burst Mode Operation Forced Continuous Mode
BUCK3[7]	0* 1	Buck3 Disabled if EN_B3 Pin Is Low Buck3 Enabled

\*denotes default power-on value.

**Table 7. Buck4 Control Command Register**

COMMAND REGISTER[BIT]	VALUE	SETTING
BUCK4[0]	0* 1	Switch Slew Rate Normal Switch Slew Rate Fast
BUCK4[1]	0* 1	Do Not Keep Enabled in Device Standby Keep Enabled in Device Standby
BUCK4[2]	0* 1	Switching Frequency 2.25MHz Switching Frequency 1.125MHz
BUCK4[3]	0* 1	Clock Phase 1 Clock Phase 2
BUCK4[4]	0* 1	Enable at Any Output Voltage Enable Only if Output Voltage Is <300mV
BUCK4[6:5]	00* 01 10	Pulse-Skipping Mode Burst Mode Operation Forced Continuous Mode
BUCK4[7]	0* 1	Buck4 Disabled if EN_B4 Pin Is Low Buck4 Enabled

\*denotes default power-on value.

## OPERATION

### SLEWING DAC REFERENCE OPERATION

Each LTC3676 step-down switching regulators error amplifier reference voltage is supplied by a 5-bit DAC with an output voltage range of 412.5mV to 800mV in 12.5mV steps. One of two 5-bit codes stored in I<sup>2</sup>C command registers is selected for input to the DAC. When a change in code is detected by the DAC control circuits, the output of the DAC is slewed at 3.5mV/ $\mu$ s to the new value.

### Dynamic Voltage Scaling

Table 8 shows the command registers used to control dynamic voltage scaling (DVS) of the step-down switching regulators input reference DAC. The command register bits DVB1A[4:0] and DVB1B[4:0] store two 5-bit inputs to the DAC reference for Buck1. The bit stored in command register DVB1A[5] selects either the 5 bits stored in DVB1A[4:0] or DVB1B[4:0] DAC as input to the DAC reference. Buck2, Buck3, and Buck4 operate the same way using their assigned “A” and “B” command registers shown in Table 8. When the DAC detects a change in its input code it automatically slews to the new value at a rate of 3.5mV/ $\mu$ s. A DVS can be initiated using the I<sup>2</sup>C select bit or using the VSTB pin.

The LTC3676 VSTB pin HIGH selects the 5 bits stored in all four DVBx “B” registers. This facilitates a simultaneous DAC slew between the values in the “A” registers and the values in the “B” registers. The VSTB pin is logically ORed with the I<sup>2</sup>C command register bit. If the I<sup>2</sup>C select bit is already set high, the “B” registers are already selected and VSTB will have no effect. If no change in output is desired using the VSTB pin, set the value in the “A” register equal to the value in the “B”.

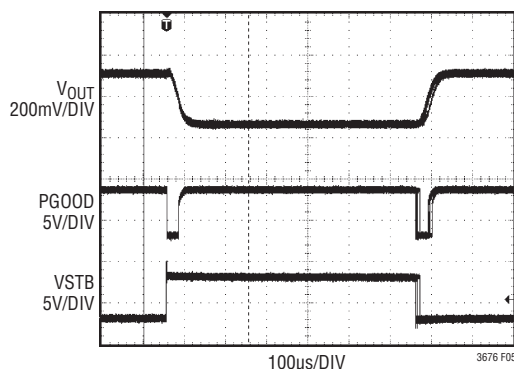


Figure 5. Dynamic Voltage Scaling

Command register bits DVB1B[5], DVB2B[5], DVB3B[5], and DVB4B[5] control whether the PGOOD status pin is pulled low while the DAC output is slewing. The default command register setting is to pull PGOOD pin low during DAC slew. During the DVS, PGOOD will be held low for just the duration of the DVS and the PGSTAT register is not affected.

Table 8. Buck1, Buck2, Buck3, and Buck4 Slewing DAC Control Command Registers

COMMAND REGISTER[BIT]	VALUE	SETTING
DVB1A[4:0]	bbbbbb	Buck1 Reference DAC Input A
DVB1A[5]	0* 1	Select DVB1A[4:0] Select DVB1B[4:0]
DVB1B[4:0]	bbbbbb	Buck1 Reference DAC Input B
DVB1B[5]	0* 1	Pull PGOOD Low Slewing Buck1 Do Not Pull PGOOD Slewing Buck1
DVB2A[4:0]	bbbbbb	Buck2 Reference DAC Input A
DVB2A[5]	0* 1	Select DVB2A[4:0] Select DVB2B[4:0]
DVB2B[4:0]	bbbbbb	Buck2 Reference DAC Input B
DVB2B[5]	0* 1	Pull PGOOD Low Slewing Buck2 Do Not Pull PGOOD Slewing Buck2
DVB3A[4:0]	bbbbbb	Buck3 Reference DAC Input A
DVB3A[5]	0* 1	Select DVB3A[4:0] Select DVB3B[4:0]
DVB3B[4:0]	bbbbbb	Buck3 Reference DAC Input B
DVB3B[5]	0* 1	Pull PGOOD Low Slewing Buck3 Do Not Pull PGOOD Slewing Buck3
DVB4A[4:0]	bbbbbb	Buck4 Reference DAC Input A
DVB4A[5]	0* 1	Select DVB4A[4:0] Select DVB4B[4:0]
DVB4B[4:0]	bbbbbb	Buck4 Reference DAC Input B
DVB4B[5]	0* 1	Pull PGOOD Low Slewing Buck4 Do Not Pull PGOOD Slewing Buck4

\*denotes default power-on value.

### PUSHBUTTON OPERATION

#### Operating Mode State Diagram

Figure 6 shows the state diagram of the LTC3676 enable and sequence controller. First application of power to V<sub>IN</sub> pin brings the controller to the power-on reset/hard reset (POR/HRST) state. In this state the I<sup>2</sup>C command registers have been set to their default values, only LDO1 is operating, and the device is waiting for pushbutton or

## OPERATION

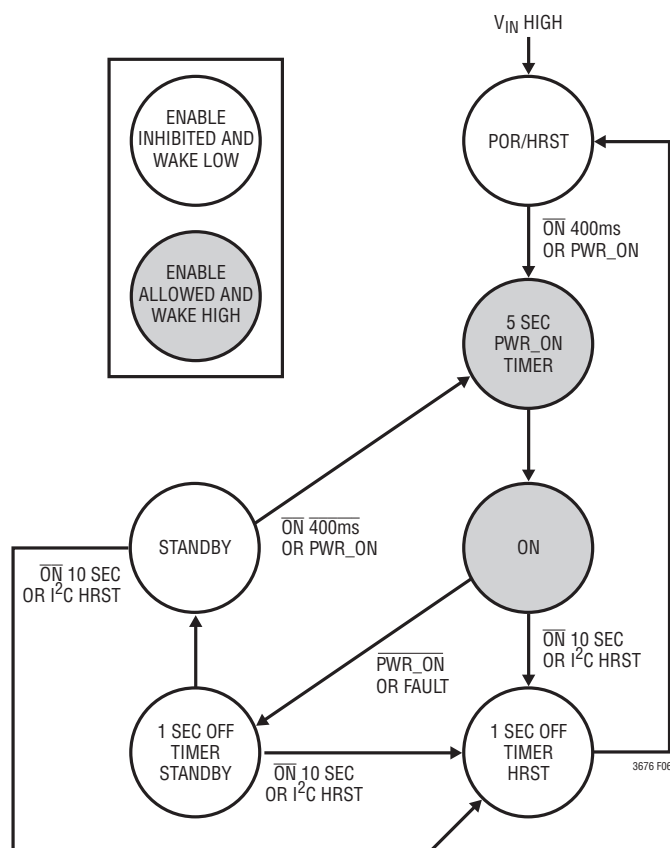


Figure 6. LTC3676 Operating Mode State Diagram

PWR\_ON inputs. Regulator enable pins and command register enable bits are ignored in POR/HRST state. In the POR/HRST state  $V_{IN}$  draws typically  $12\mu A$ .

### Power Up Using Pushbutton

When the  $\overline{ON}$  pin is held low for 400ms the WAKE pin is pulled high, enable pins are recognized, and the five second PWR\_ON timer is started. If in the ON state and PWR\_ON is low or a fault is detected, then WAKE is brought low and after a 1 second power-down time, the STANDBY state is entered. In STANDBY, the enable bits in the command registers are cleared and enable pins are ignored. Table 9 shows the control of command registers, enables, and WAKE at each state.

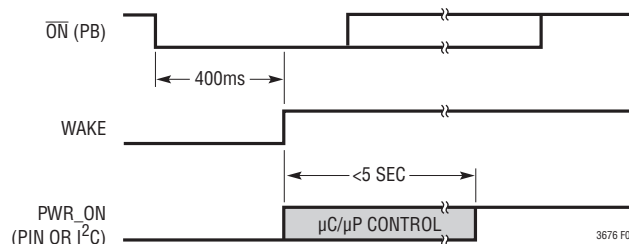


Figure 7. Power Up Using Pushbutton

The 5 second power-on state is intended for the system to detect that power rails are correct and either drive PWR\_ON pin high or set command register bit CNTRL[7] high to keep the rails active. If there were a system level problem keeping the processor from driving PWR\_ON, then the LTC3676 will pull WAKE low, shut off all regulators, and enter the STANDBY state. The STANDBY state is also a low power,  $12\mu A$  (typical) state.

Table 9. Register, Enable, WAKE Control During Operating Mode State Control

STATE	REGISTERS	ENABLES	WAKE
POR/HRST DEFAULT	R/W	Inhibited	LOW
5 SEC PWR_ON TIMER	R/W	Allowed	HIGH
ON	R/W	Allowed	HIGH
1 SEC OFF TIMER HRST	Set to POR Defaults	Sequence Down	LOW
1 SEC OFF TIMER STANDBY	I <sup>2</sup> C Enable and SW Mode Bits Cleared	Sequence Down	LOW
STANDBY	R/W	Inhibited	LOW

### Power Down Using Pushbutton

When in the ON state, the system controller is responsible for deciding what action to take when a pushbutton event occurs. By monitoring the  $\overline{IRQ}$  status pin and IRQSTAT[0] status register bit, the controller can detect a pushbutton request. If a power-down into standby state is desired then the controller should drive PWR\_ON low and set command register bit CNTRL[7] low.



## OPERATION

The software control mode bit is reset in the one second standby and hard reset timer states so a pin strapped sequence begins at the next LTC3676 power on.

### Keep Alive Operation

Each regulator has a dedicated command register keep alive bit that, when set, forces a regulator to be enabled regardless of the enable pins, command register enable bits, or the operating state of the LTC3676. A hard reset or fault shutdown resets the keep alive bits.

### POWER OFF SEQUENCING

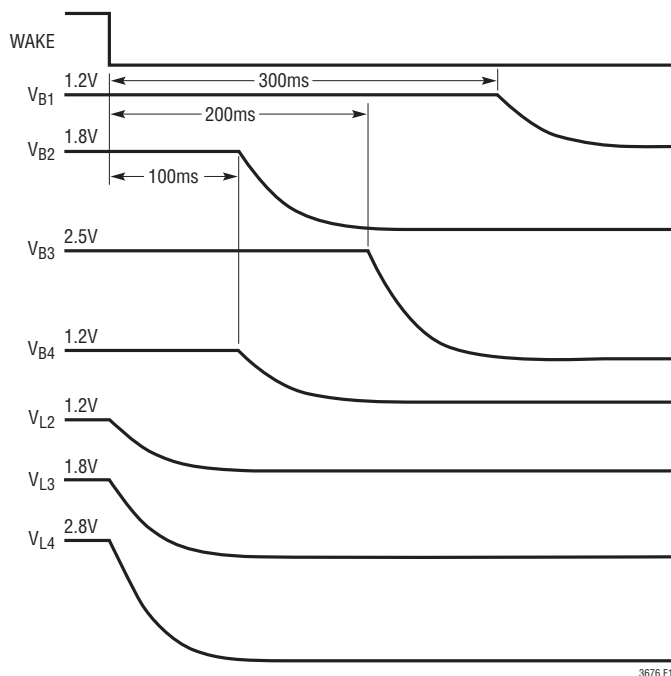
Sequence down command registers SQD1 and SQD2 are used to set the time, relative to WAKE falling, that a regulator is disabled either by lowering PWR\_ON, or a fault induced shutdown. Table 10 shows register settings for SQD1 and SQD2.

**Table 10. Sequence Down Control Command Register Settings**

COMMAND REGISTER[BIT]	VALUE	SETTING
SQD1[1:0]	00*	Disable Buck1 at Falling WAKE
	01	Disable Buck1 at Falling WAKE + 100ms
	10	Disable Buck1 at Falling WAKE + 200ms
	11	Disable Buck1 at Falling WAKE + 300ms
SQD1[3:2]	00*	Disable Buck2 at Falling WAKE
	01	Disable Buck2 at Falling WAKE + 100ms
	10	Disable Buck2 at Falling WAKE + 200ms
	11	Disable Buck2 at Falling WAKE + 300ms
SQD1[5:4]	00*	Disable Buck3 at Falling WAKE
	01	Disable Buck3 at Falling WAKE + 100ms
	10	Disable Buck3 at Falling WAKE + 200ms
	11	Disable Buck3 at Falling WAKE + 300ms
SQD1[7:6]	00*	Disable Buck4 at Falling WAKE
	01	Disable Buck4 at Falling WAKE + 100ms
	10	Disable Buck4 at Falling WAKE + 200ms
	11	Disable Buck4 at Falling WAKE + 300ms
SQD2[1:0]	00*	Disable LDO2 at Falling WAKE
	01	Disable LDO2 at Falling WAKE + 100ms
	10	Disable LDO2 at Falling WAKE + 200ms
	11	Disable LDO2 at Falling WAKE + 300ms
SQD2[3:2]	00*	Disable LDO3 at Falling WAKE
	01	Disable LDO3 at Falling WAKE + 100ms
	10	Disable LDO3 at Falling WAKE + 200ms
	11	Disable LDO3 at Falling WAKE + 300ms
SQD2[5:4]	00*	Disable LDO4 at Falling WAKE
	01	Disable LDO4 at Falling WAKE + 100ms
	10	Disable LDO4 at Falling WAKE + 200ms
	11	Disable LDO3 at Falling WAKE + 300ms

\*denotes default power-on value.

Figure 12 shows an example of a shutdown sequence. In this example, the bits in command registers SQD1 and SQD2 are set so that LDO2, LDO3, and LDO4 shut off at the same time as WAKE. Buck2 and Buck4 shut off 100ms after WAKE. Buck3 shuts off 200ms after wake and Buck1 shuts off 300ms after WAKE.



**Figure 12. Power-Down Sequence**

### FAULT DETECTION AND REPORTING

The LTC3676 has fault detection circuits that monitor for  $V_{IN}$  undervoltage, die overtemperature, and regulator output undervoltage. Status of the fault detect circuits is indicated by the  $\overline{IRQ}$  and PGOOD pins and the IRQSTAT and PGSTAT status registers.

### $V_{IN}$ Undervoltage

The undervoltage (UV) circuit monitors the input supply voltage,  $V_{IN}$ , and when the voltage falls below 2.45V creates a FAULT condition that forces the LTC3676 into the standby state. The LTC3676 also provides a (UV) warning that is triggered at user programmable  $V_{IN}$  voltages as shown in Table 11.

## OPERATION

**Table 11. Undervoltage Warning Threshold Command Register Settings**

COMMAND REGISTER[BIT]	VALUE	FALLING $V_{IN}$ THRESHOLD
CNTRL[4:2]	000*	2.7V
	001	2.8V
	010	2.9V
	011	3.0V
	100	3.1V
	101	3.2V
	110	3.3V
	111	3.4V

\*denotes default power-on value.

### Over Temperature

To prevent thermal damage the LTC3676 incorporates an overtemperature (OT) circuit. When the die temperature reaches 155°C the OT circuits create a FAULT condition that forces the LTC3676 into standby. When the OT circuit detects the temperature falls below 140°C the FAULT condition is cleared. The LTC3676 also has an OT warning circuit that indicates the die temperature is approaching the OT fault threshold. The OT warning threshold is user programmable as shown in Table 12.

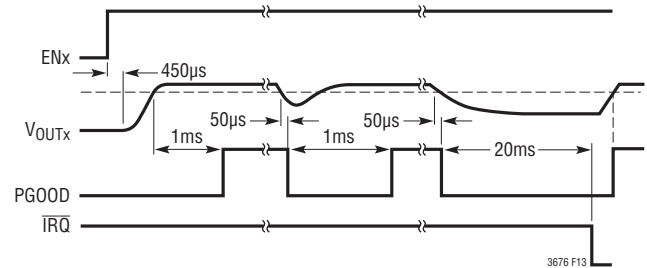
**Table 12. Overtemperature Warning Threshold Command Register Settings**

COMMAND REGISTER[BIT]	VALUE	OT WARNING THRESHOLD
CNTRL[1:0]	00*	10°C Below OT Fault
	01	20°C Below OT Fault
	10	30°C Below OT Fault
	11	40°C Below OT Fault

\*denotes default power-on value.

### PGOOD Status Pin

The PGOOD open-drain status pin is pulled low when all regulators are disabled. PGOOD is released when all enabled regulator outputs are above 93% of programmed value. When any enabled regulator output falls below 92% of its programmed value for longer than 50µs the PGOOD pin is pulled low. The 50µs transient filter on PGOOD prevents PGOOD glitches due to transients. If the error condition persists for longer than 20ms, the  $\overline{IRQ}$  pin is pulled low and status register IRQSTAT bit 2 is set to indicate a persistent PGOOD fault. The PGOOD pin is held low for the duration of the low output condition plus 1ms. Figure 13 shows the timing of PGOOD during enable and fault events.



**Figure 13. Output Low Voltage PGOOD and  $\overline{IRQ}$  Timing**

### PGSTAT and MSKPG Registers

The power good status of each regulator is accessible through the LTC3676 I<sup>2</sup>C interface by reading the contents of the PGSTAT status register. Table 13 shows the PGSTAT register contents. The data in the PGSTATL register is held for the length of the low voltage condition plus 1ms. The data in the PGSTATRT register is held only for the duration of the low voltage condition.

**Table 13. Power Good Status Register**

STATUS REGISTER[BIT]	VALUE	REGULATOR OUTPUT LOW STATUS
PGSTAT[0]	0	Buck1 Output Low
	1	Buck1 Output OK
PGSTAT[1]	0	Buck2 Output Low
	1	Buck2 Output OK
PGSTAT[2]	0	Buck3 Output Low
	1	Buck3 Output OK
PGSTAT[3]	0	Buck4 Output Low
	1	Buck4 Output OK
PGSTAT[4]	0	LD01 Output Low
	1	LD01 Output OK
PGSTAT[5]	0	LD02 Output Low
	1	LD02 Output OK
PGSTAT[6]	0	LD03 Output Low
	1	LD03 Output OK
PGSTAT[7]	0	LD04 Output Low
	1	LD04 Output OK

Each regulator has a corresponding bit in the MSKPG status register as shown in Table 14. When set, a bit blocks the PGOOD pin from being pulled low in the event of a low output voltage fault from its matching regulator. Setting a bit in the MSKPG command register does not mask the status in the PGSTAT status register.

## OPERATION

**Table 14. Power Good Status Masking Command Register**

COMMAND REGISTER[BIT]	VALUE	
MSKPG [0]	0 1*	Mask Buck1 PGOOD Status Pass Buck1 PGOOD Status
MSKPG [1]	0 1*	Mask Buck2 PGOOD Status Pass Buck2 PGOOD Status
MSKPG [2]	0 1*	Mask Buck3 PGOOD Status Pass Buck3 PGOOD Status
MSKPG [3]	0 1*	Mask Buck4 PGOOD Status Pass Buck4 PGOOD Status
MSKPG [5]	0 1*	Mask LDO2 PGOOD Status Pass LDO2 PGOOD Status
MSKPG [6]	0 1*	Mask LDO3 PGOOD Status Pass LDO3 PGOOD Status
MSKPG [7]	0 1*	Mask LDO4 PGOOD Status Pass LDO4 PGOOD Status

\*denotes default power-on value.

### IRQ Status Pin

The  $\overline{\text{IRQ}}$  pin is pulled and latched low when undervoltage, overtemperature or persistent PGOOD events occur. The  $\overline{\text{IRQ}}$  pin is cleared by addressing the CLRQ command register or by holding  $\overline{\text{ON}}$  low for 50ms.

**Table 15. Interrupt Request Status Register**

STATUS REGISTER[BIT]	VALUE	IRQSTAT REGISTER BIT MEANING
IRQSTAT [0]	0 1	Pushbutton Status Active (Real Time)
IRQSTAT [1]	0 1	Hard Reset Occurred
IRQSTAT [2]	0 1	PGOOD Timeout Occurred
IRQSTAT [3]	0 1	Undervoltage Warning
IRQSTAT [4]	0 1	Undervoltage Standby Occurred
IRQSTAT [5]	0 1	Overtemperature Warning
IRQSTAT [6]	0 1	Overtemperature Standby Occurred

### IRQSTAT and MSKIRQ Registers

The bits in the MSKIRQ command register are set to mask warning, fault, and pushbutton status reporting to the  $\overline{\text{IRQ}}$  pin. When set to mask, the  $\overline{\text{IRQ}}$  pin is not pulled low as a result of a fault or warning. Even though the  $\overline{\text{IRQ}}$  pin is not pulled low the masked bit is set in the IRQSTAT register. When undervoltage, overtemperature faults, and hard reset signals are masked, the  $\overline{\text{IRQ}}$  pin is not pulled low but LTC3676 state controller is pushed into the STANDBY or POR/HRST state. Accessing the CLRQ status register clears the latched bits in the IRQSTAT status register and releases the  $\overline{\text{IRQ}}$  pin.

**Table 16. Interrupt Request Mask Command Register**

COMMAND REGISTER[BIT]	VALUE	
MSKIRQ [0]	0* 1	Pass Pushbutton Status Mask Pushbutton Status
MSKIRQ [2]	0* 1	Pass PGOOD Timeout Mask PGOOD Timeout
MSKIRQ [3]	0* 1	Pass Undervoltage Warning Mask Undervoltage Warning
MSKIRQ [4]	0* 1	Pass Undervoltage Shutdown Mask Undervoltage Shutdown
MSKIRQ [5]	0* 1	Pass Overtemperature Warning Mask Overtemperature Warning
MSKIRQ [6]	0* 1	Pass Overtemperature Shutdown Mask Overtemperature Shutdown

\*denotes default power-on value.

IRQ and IRQSTAT are not cleared by hard reset or fault shutdown. If  $V_{\text{IN}}$  remains applied while the LTC3676 is in STANDBY or POR/HRST then IRQSTAT may be read on the subsequent power up to determine if a fault or hard reset occurred.

### RSTO Status Pin

The LTC3676  $\overline{\text{RSTO}}$  status pin is pulled low when always-on LDO1 is 8% below its programmed value or when the LTC3676 is in the one second HRST timer state.



## OPERATION

### Hard Reset

A hard reset can be initiated by holding the  $\overline{ON}$  pin low or writing to the HRST command register. Bit six of the CNTRL command register determines how long  $\overline{ON}$  must remain low to initiate the hard reset. A hard reset sets all I<sup>2</sup>C command register bits to their default power-on state. Table 17 shows the command register control of hard reset function.

**Table 17. Hard Reset Time Control Command Register**

COMMAND REGISTER[BIT]	VALUE	SETTING
CNTRL[6]	0*	10 seconds
	1	5 seconds

\*denotes default power-on value.

A hard reset command will push the LTC3676 state controller through the 1 second HRST timer state and into the POR/HRST state.

### Fault Shutdown

An undervoltage or overtemperature fault will push the LTC3676 state controller through the 1 second standby timer state and into standby state. If a down sequence is selected in the command registers, it will be executed during the 1 second power down interval.

### LTC3676-1 Operation

The LTC3676-1 option supports DDR memory operation by generating a DDR termination reference and supply rail equal to one-half the voltage applied to VDDQIN Pin 8.

An internal resistive divider creates a reference voltage of one-half the voltage on VDDQIN. This reference is used by the  $V_{TT}$  reference buffer to output one-half of VDDQIN on VTTR Pin 9. The VTTR voltage is used as the reference for 1.5A switching regulator 1 which is used as the DDR termination supply.

Figure 1 shows typical application connections for the LTC3676-1 DDR termination reference and termination supply.

LDO4 has I<sup>2</sup>C command register selectable output voltages of 1.2V (default), 1.8V, 2.5V and 2.8V and is enabled only using the I<sup>2</sup>C command register. Table 18 shows the LDO4 command register controls for the LTC3676-1.

**Table 18. LDO4 Control Command Register Setting (LTC3676-1)**

COMMAND REGISTER[BIT]	VALUE	SETTING
LDOB[0]	0*	Do Not Keep Alive LDO4 in Standby
	1	Keep Alive LDO4 in Standby
LDOB[1]	0*	Enable LDO4 at Any Output Voltage
	1	Enable LDO4 Only if Output Voltage Is <300mV
LDOB[2]	0*	LDO4 Disabled
	1	LDO4 Enable
LDOB[4:3]	00*	1.2V
	01	2.5V
	10	2.8V
	11	3.0V

\*denotes default power-on value.

### I<sup>2</sup>C OPERATION

The LTC3676 communicates with a bus master using the standard I<sup>2</sup>C 2-wire interface. The timing diagram in Figure 14 shows the relationship of the signals on the bus. The two bus lines, SDA and SCL must be high when the bus is not in use. External pull-up resistors or current sources, such as the LTC1694 SMBus accelerator, are required on SDA and SCL. The LTC3676 is both a slave receiver and slave transmitter. The I<sup>2</sup>C control signals, SDA and SCL are scaled internally to the  $DV_{DD}$  supply.  $DV_{DD}$  must be connected to the same power supply as the bus pull-up resistors.

The I<sup>2</sup>C port has an undervoltage lockout on the  $DV_{DD}$  pin. When  $DV_{DD}$  is below approximately 1V, the I<sup>2</sup>C serial port is cleared and the command registers are set to default POR values.

The complete I<sup>2</sup>C command register table is shown in Table 21.

## OPERATION

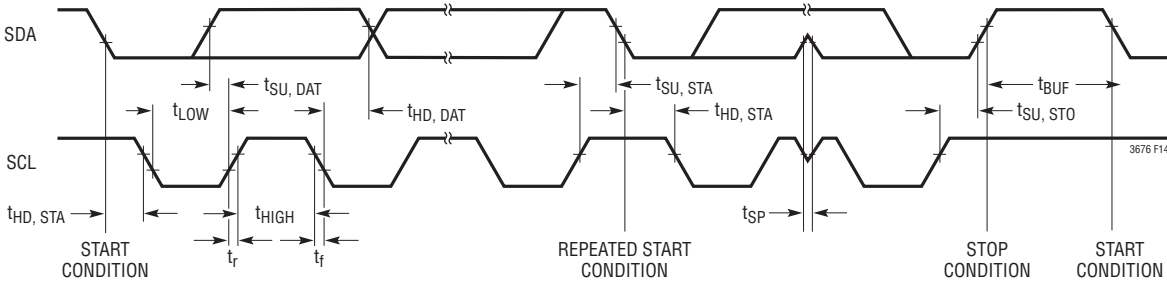


Figure 14. LTC3676 I<sup>2</sup>C Serial Port Timing

### I<sup>2</sup>C Bus Speed

The I<sup>2</sup>C port operates at speeds up to 400kHz. It has built in timing delays to ensure correct operation when addressed from an I<sup>2</sup>C compliant master device. It also contains input filters designed to suppress glitches should the bus become corrupted.

### I<sup>2</sup>C START and STOP Conditions

A bus master signals the beginning of communications by transmitting a START condition. A START condition is generated by transitioning SDA from HIGH to LOW while SCL is HIGH. The master may transmit either the slave write or the slave read address. Once data is written to the LTC3676, the master may transmit a STOP condition which commands the LTC3676 to act upon its new command set. A STOP condition is sent by the master by transitioning SDA from LOW to HIGH while SCL is HIGH. The bus is then free for communication with another I<sup>2</sup>C device.

### I<sup>2</sup>C Byte Format

Each byte sent to or received from the LTC3676 must be 8 bits long followed by an extra clock cycle for the acknowledge bit. The data should be sent to the LTC3676 most significant bit (MSB) first.

### I<sup>2</sup>C Acknowledge

The acknowledge signal is used for handshaking between the master and the slave. When the LTC3676 is written to, it acknowledges its write address and subsequent data bytes. When it is read from, the LTC3676 acknowledges its read address only. The bus master should acknowledge data returned from the LTC3676.

An acknowledge generated by the LTC3676 lets the master know that the latest byte of information was received. The master generates the acknowledge related clock and releases the SDA line during the acknowledge clock cycle. The LTC3676 pulls down the SDA line during the write acknowledge clock pulse so that it is a stable LOW during the HIGH period of this clock pulse.

At the end of a byte of data transferred from the LTC3676 during a READ operation, the LTC3676 releases the SDA line to allow the master to acknowledge receipt of the data. Failure of the master to acknowledge data from the LTC3676 has no effect on the operation of the I<sup>2</sup>C port.

### I<sup>2</sup>C Slave Address

The LTC3676 responds to factory programmed read and write addresses. The least significant bit of the address byte is 0 when writing data and 1 when reading data. Table 19 shows read and write addresses for the LTC3676 options.

Table 19. LTC3676 and LTC3676-1 I<sup>2</sup>C Read and Write Addresses

LTC PART NUMBER	R/W	ADDRESS
LTC3676	$\bar{W}$	0111 1000, 0x78
LTC3676	R	0111 1001, 0x79
LTC3676-1	$\bar{W}$	0111 1010, 0x7A
LTC3676-1	R	0111 1011, 0x7B

### I<sup>2</sup>C Write Operation

The LTC3676 has twenty-two command registers for control input. They are accessed by the I<sup>2</sup>C port via a sub-addressed writing system.

## OPERATION

A single write cycle of the LTC3676 consists of exactly three bytes except when a clear interrupt or hard reset command is written. The first byte is always the LTC3676 write address. The second byte represents the LTC3676 sub-address. The sub-address is a pointer which directs the subsequent data byte within the LTC3676. The third byte consists of the data to be written to the location pointed to by the sub-address.

As shown in Figure 15, the LTC3676 supports multiple sub-addressed write operations. Data pairs sent following the chip write address are interpreted as sub-address and data. Any number of sub-address and data pairs may be sent. The data in the command registers is not acted on by the LTC3676 until a STOP signal is issued.

The LTC3676 will keep interim writes to the registers when a repeat START condition occurs. A repeat start may be used to set up other devices on the I<sup>2</sup>C bus prior to sending a STOP condition. The LTC3676 will act on the data written prior to the repeat start when a STOP condition is detected.

### I<sup>2</sup>C Read Operation

Figure 16 shows the LTC3676 command register read sequence. The bus master reads a byte of data from a LTC3676 command or status register by first writing the LTC3676 write address followed by the sub-address to be read from. The LTC3676 acknowledges each of the two bytes. Next, the bus master initiates a new START condition and sends the LTC3676 read address. Following the acknowledge of the read address by the LTC3676, the LTC3676 pushes data onto the I<sup>2</sup>C bus for the 8 clock cycles. The bus master then acknowledges the data on its ninth clock.

The last read sub-address that is written to the LTC3676 is stored. This allows repeated polling of a command or status register without the need to re-write its sub-address. Additionally, the last register written may be immediately read by issuing a START condition followed by read address and clocking out the data.

OPERATION

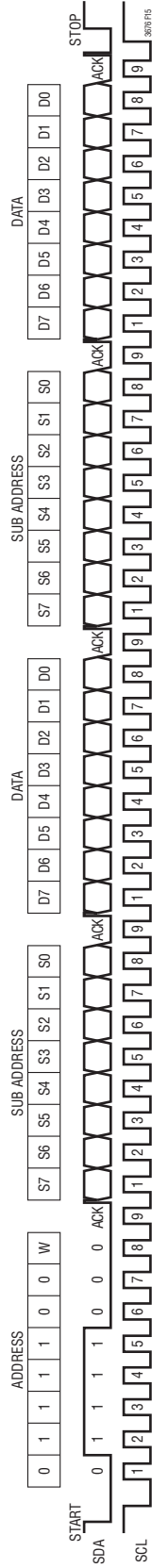


Figure 15. LTC3676 I<sup>2</sup>C Serial Port Multiple Write Pattern

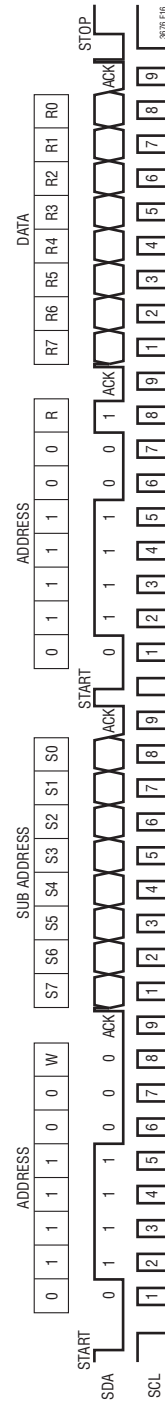


Figure 16. LTC3676 I<sup>2</sup>C Serial Port Read Pattern

## OPERATION

**Table 21. LTC3676 Command Registers**

REG	NAME	B[7]	B[6]	B[5]	B[4]	B[3]	B[2]	B[1]	B[0]	DEFAULT
0x01	BUCK1	Enable: 0 = Disabled if EN_B1 Low 1 = Enabled	Mode: 00 = Pulse-Skipping 01 = Burst 10 = Forced Continuous		Start-Up: 0 = Enable at Any Output Voltage 1 = Enable Only if Output <300mV	Phase Select: 0 = Clock Phase 1 1 = Clock Phase 2	Clock Rate: 0 = 2.25MHz 1 = 1.125MHz	Keep Alive Buck1: 0 = Do Not Keep Alive 1 = Keep Alive in Shutdown.	Switch DV/DT Control: 0 = Slow 1 = Fast	0000 0000
0x02	BUCK2	Enable: 0 = Disabled if EN_B2 Low 1 = Enabled	Mode: 00 = Pulse-Skipping 01 = Burst 10 = Forced Continuous		Start-Up: 0 = Enable at Any Output Voltage 1 = Enable Only if Output <300mV	Phase Select: 0 = Clock Phase 1 1 = Clock Phase 2	Clock Rate: 0 = 2.25MHz 1 = 1.125MHz	Keep Alive Buck2: 0 = Do Not Keep Alive 1 = Keep Alive in Shutdown	Switch DV/DT Control: 0 = Slow 1 = Fast	0000 0000
0x03	BUCK3	Enable: 0 = Disabled if EN_B3 Low 1 = Enabled	Mode: 00 = Pulse-Skipping 01 = Burst 10 = Forced Continuous		Start-Up: 0 = Enable at Any Output Voltage 1 = Enable Only if Output <300mV	Phase Select: 0 = Clock Phase 1 1 = Clock Phase 2	Clock Rate: 0 = 2.25MHz 1 = 1.125MHz	Keep Alive Buck3: 0 = Do Not Keep Alive 1 = Keep Alive in Shutdown	Switch DV/DT Control: 0 = Slow 1 = Fast	0000 0000
0x04	BUCK4	Enable: 0 = Disabled if EN_B4 Low 1 = Enabled	Mode: 00 = Pulse-Skipping 01 = Burst 10 = Forced Continuous		Start-Up: 0 = Enable at Any Output Voltage 1 = Enable Only if Output <300mV	Phase Select: 0 = Clock Phase 1 1 = Clock Phase 2	Clock Rate: 0 = 2.25MHz 1 = 1.125MHz	Keep Alive Buck4: 0 = Do Not Keep Alive 1 = Keep Alive in Shutdown	Switch DV/DT Control: 0 = Slow 1 = Fast	0000 0000
0x05	LDOA	Not Available	Not Available	Enable LDO3: 0 = Disabled if EN_L3 Low 1 = Enabled	Start-Up LDO3: 0 = Enable at Any Output Voltage 1 = Enable Only if Output <300mV	Keep Alive LDO3: 0 = Do Not Keep Alive 1 = Keep Alive in Shutdown.	Enable LDO2: 0 = Disabled if EN_L2 Low 1 = Enabled	Start-Up LDO2: 0 = Enable at Any Output Voltage 1 = Enable Only if Output <300mV	Keep Alive LDO2: 0 = Do Not Keep Alive 1 = Keep Alive in Shutdown	0000 0000
0x06	LDOB	Not Available	Not Available	Not Available	LTC3676-1 LDO4 Output Voltage: 00 = 1.2V 01 = 2.5V 10 = 2.8V 11 = 3.0V		Enable LDO4: 0 = Disabled if EN_L4 Low 1 = Enabled	Start-Up LDO4: 0 = Enable at Any Output Voltage 1 = Enable Only if Output <300mV	Keep Alive LDO4: 0 = Do Not Keep Alive 1 = Keep Alive in Shutdown	0000 0000
0x07	SQD1	Sequence Down Buck4: 00 = With WAKE 01 = WAKE + 100ms 10 = WAKE + 200ms 11 = WAKE + 300ms		Sequence Down Buck3: 00 = With WAKE 01 = WAKE + 100ms 10 = WAKE + 200ms 11 = WAKE + 300ms		Sequence Down Buck2: 00 = With WAKE 01 = WAKE + 100ms 10 = WAKE + 200ms 11 = WAKE + 300ms		Sequence Down Buck1: 00 = With WAKE 01 = WAKE + 100ms 10 = WAKE + 200ms 11 = WAKE + 300ms		0000 0000

## OPERATION

REG	NAME	B[7]	B[6]	B[5]	B[4]	B[3]	B[2]	B[1]	B[0]	DEFAULT
0x08	SQD2	Not Available	Not Available	Sequence Down LD04: 00 = With WAKE 01 = WAKE + 100ms 10 = WAKE + 200ms 11 = WAKE + 300ms		Sequence Down LD03: 00 = With WAKE 01 = WAKE + 100ms 10 = WAKE + 200ms 11 = WAKE + 300ms		Sequence Down LD02: 00 = With WAKE 01 = WAKE + 100ms 10 = WAKE + 200ms 11 = WAKE + 300ms		0000 0000
0x09	CNTRL	PWR_ON: 0 = Not PWR_ON 1 = PWR_ON "ORed" with PWR_ON PIN	Pushbutton Hard Reset Timer: 0 = 10 sec 1 = 5 sec	Software Control Mode: 0 = Pin or Register Control 1 = Inhibit Pin Control	UV Warning Threshold: 000 = 2.7V 001 = 2.8V 010 = 2.9V 011 = 3.0V 100 = 3.1V 101 = 3.2V 110 = 3.3V 111 = 3.4V			Over temperature Warning Levels: 00 = 10°C Below Overtemperature 01 = 20°C Below Overtemperature 10 = 30°C Below Overtemperature 11 = 40°C Below Overtemperature		0000 0000
0x0A	DVB1A	Not Available	Not Available	Buck1 Reference Select: 0 = DVB1A[4-0] 1 = DVB1B[4-0]	Buck1 Feedback Reference Input (VA): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001
0x0B	DVB1B	Not Available	Not Available	PGOOD Mask: 0 = PGOOD Low When Slewing 1 = PGOOD Not Forced Low When Slewing	Buck1 Feedback Reference Input (VB): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001
0x0C	DVB2A	Not Available	Not Available	Buck2 Reference Select: 0 = DVB2A[4-0] 1 = DVB2B[4-0]	Buck2 Feedback Reference Input (VA): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001
0x0D	DVB2B	Not Available	Not Available	PGOOD Mask: 0 = PGOOD Low When Slewing 1 = PGOOD Not Forced Low When Slewing	Buck2 Feedback Reference Input (VB): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001
0x0E	DVB3A	Not Available	Not Available	Buck3 Reference Select: 0 = DVB3A[4-0] 1 = DVB3B[4-0]	Buck3 Feedback Reference Input (VA): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001

## OPERATION

REG	NAME	B[7]	B[6]	B[5]	B[4]	B[3]	B[2]	B[1]	B[0]	DEFAULT
0x0F	DVB3B	Not Available	Not Available	PGOOD Mask: 0 = PGOOD Low When Slewing 1 = PGOOD Not Forced Low When Slewing	Buck3 Feedback Reference Input (VB): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001
0x10	DVB4A	Not Available	Not Available	Buck4 Reference. Select: 0 = DVB4A[4-0] 1 = DVB4B[4-0]	Buck4 Feedback Reference Input (VA): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001
0x11	DVB4B	Not Available	Not Available	PGOOD Mask: 0 = PGOOD Low When Slewing 1 = PGOOD Not Forced Low When Slewing	Buck4 Feedback Reference Input (VB): 00000 = 412.5mV 11001 = 725mV 11111 = 800mV 12.5mV Step Size					0001 1001
0x12	MSKIRQ	Not Available	Mask Over- temperature Shutdown	Mask Over- temperature Warning	Mask Undervoltage Shutdown	Mask Undervoltage Warning	Mask PGOOD Timeout	Not Available	Mask Push Button Status	0000 0000
0x13	MSKPG	Allow LDO 4 PGOOD Fault	Allow LDO 3 PGOOD Fault	Allow LDO 2 PGOOD Fault	Not Available	Allow Buck 4 PGOOD Fault	Allow Buck 3 PGOOD Fault	Allow Buck 2 PGOOD Fault	Allow Buck 1 PGOOD Fault	1111 1111
0x14	USER	User Bit 7	User Bit 6	User Bit 5	User Bit 4	User Bit 3	User Bit 2	User Bit 1	User Bit 0	0000 0000
0x1E	HRST	Hard Reset Command. No Data.								
0x1F	CLRIRQ	Clear IRQ Command. No Data								

Table 22. LTC3676 Status Registers

REG	NAME	B[7]	B[6]	B[5]	B[4]	B[3]	B[2]	B[1]	B[0]
0x15	IRQSTAT	Not Available	Over- temperature Shutdown	Over- temperature Warning	Undervoltage Shutdown	Undervoltage Warning	PGOOD Timeout	Hard Reset	Pushbutton Status (Real Time)
0x16	PGSTATL	LD04 PGOOD Hold 1ms	LD03 PGOOD Hold 1ms	LD02 PGOOD Hold 1ms	LD01 PGOOD Hold 1ms	Buck4 PGOOD Hold 1ms	Buck3 PGOOD Hold 1ms	Buck2 PGOOD Hold 1ms	Buck1 PGOOD Hold 1ms
0x17	PGSTATRT	LD04 PGOOD	LD03 PGOOD	LD02 PGOOD	LD01 PGOOD	Buck4 PGOOD	Buck3 PGOOD	Buck2 PGOOD	Buck1 PGOOD

## APPLICATIONS INFORMATION

### THERMAL CONSIDERATIONS AND BOARD LAYOUT

#### Printed Circuit Board Power Dissipation

In order to ensure optimal performance and the ability to deliver maximum output power to any regulator, it is critical that the exposed ground pad on the backside of the LTC3676 package be soldered to a ground plane on the board. The exposed pad is the only GND connection for the LTC3676. Correctly soldered to a 2500mm<sup>2</sup> ground plane on a double-sided 1oz copper board, the LTC3676 has a thermal resistance( $\theta_{JA}$ ) of approximately 34°C/W. Failure to make good thermal contact between the exposed pad on the backside of the package and an adequately sized ground plane will result in thermal resistances far greater than 34°C/W. To ensure the junction temperature of the LTC3676 die does not exceed the maximum rated limit and to prevent overtemperature faults, the power output of the LTC3676 must be managed by the application. The total power dissipation in the LTC3676 is approximated by summing the power dissipation in each of the switching regulators and the LDO regulators. The power dissipation in a switching regulator is estimated by:

$$P_{D(SWX)} = V_{OUTX} \cdot I_{OUTX} \cdot \frac{100 \cdot \text{Eff}\%}{100} \text{ (W)}$$

Where  $V_{OUTX}$  is the programmed output voltage  $I_{OUTX}$  is the load current and Eff is the % efficiency that can be measured or looked up from the efficiency curves for the programmed output voltage.

The power dissipated by an LDO regulator is estimated by:

$$P_{DLDOx} = V_{IN(LDOx)} - V_{LDOx} \cdot I_{LDOx} \text{ (W)}$$

where  $V_{LDOx}$  is the programmed output voltage,  $V_{IN(LDOx)}$  is the LDO supply voltage, and  $I_{LDOx}$  is the output load current. If one of the switching regulator outputs is used as an LDO supply voltage, remember to include the LDO supply current in the switching regulator load current for calculating power loss.

An example using the equations above with the parameters in Table 23 shows an application that is at a junction temperature of 120°C at an ambient temperature of 55°C. LDO2, LDO3, and LDO4 are powered by step-down Buck2 and Buck4. The total load on Buck2 and Buck4 is the sum

of the application load and the LDO load. This example is with the LDO regulators at one third rated current and the switching regulators at three quarters rated current.

**Table 23. LTC3676 Power Loss Example**

	V <sub>IN</sub>	V <sub>OUT</sub>	APPLICATION LOAD (mA)	TOTAL LOAD (mA)	EFF (%)	P <sub>D</sub> (mW)
LDO1	3.8	1.2	0.01	0.010	–	26.00
LDO2	1.8	1.2	0.1	0.100	–	60.00
LDO3	3.3	1.8	0.1	0.100	–	150.00
LDO4	3.3	2.5	0.1	0.100	–	80.00
Buck1	3.8	1.2	1.875	1.875	80	450.00
Buck2	3.8	1.8	1.775	1.875	85	506.25
Buck3	3.8	1.25	1.125	1.125	80	281.25
Buck4	3.8	3.3	0.925	1.125	90	371.25
Total Power =						1925
Internal Junction Temperature at 55°C Ambient						120°C

#### Printed Circuit Board Layout

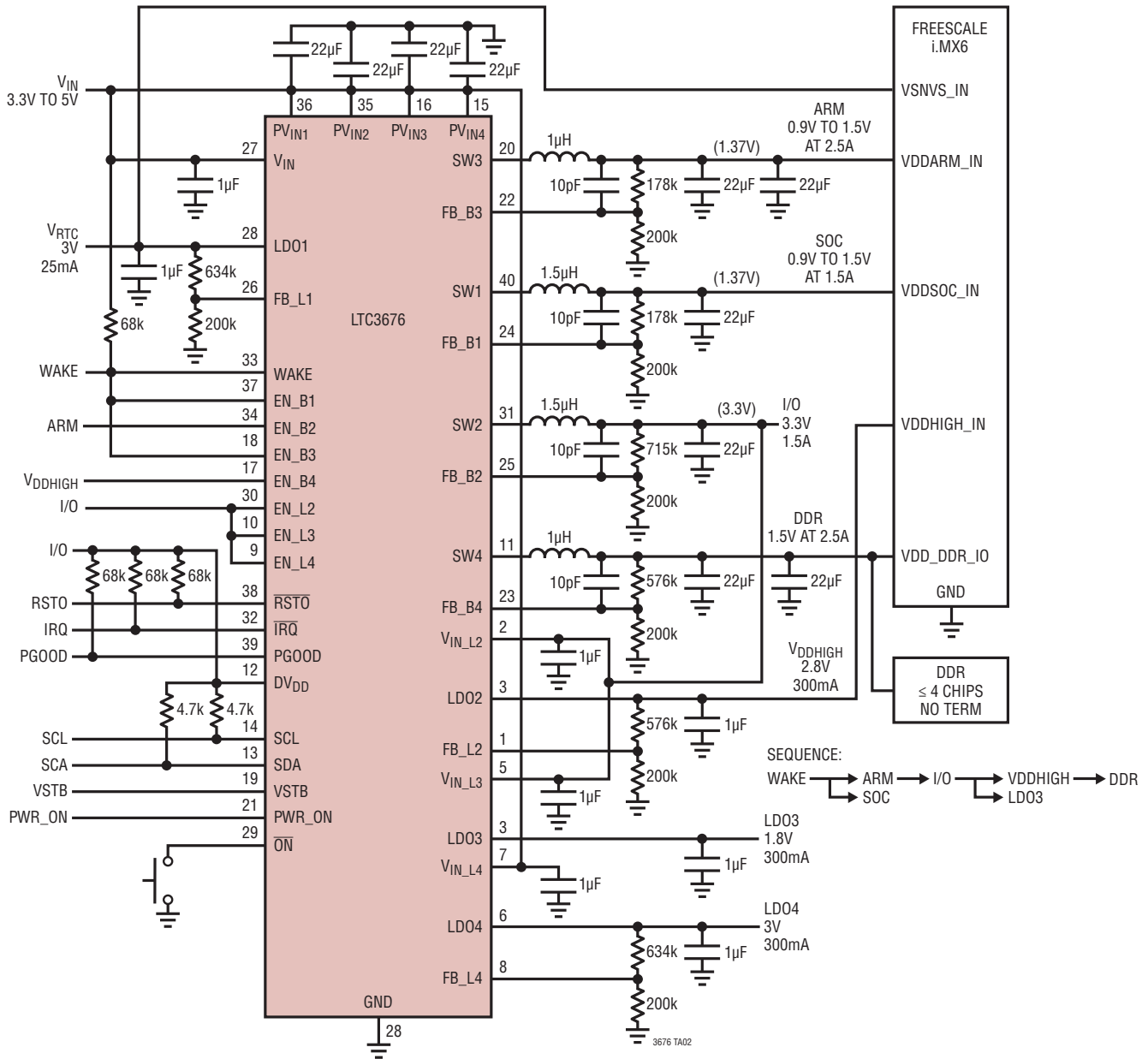
When laying out the printed circuit board, the following checklist should be followed to ensure proper operation of the LTC3676:

1. Connect the exposed pad of the package (Pin 41) directly to a large ground plane to minimize thermal and electrical impedance.
2. The switching regulator input supply traces to their decoupling capacitors should be as short as possible. Connect the GND side of the capacitors directly to the ground plane of the board. The decoupling capacitors provide the AC current to the internal power MOSFETs and their drivers. It is important to minimize inductance from the capacitors to the LTC3676 pins.
3. Minimize the switching power traces connecting SW1, SW2, SW3, and SW4 to the inductors to reduce radiated EMI and parasitic coupling. Keep sensitive nodes such as the feedback pins away from or shielded from the large voltage swings on the switching nodes.
4. Minimize the length of the connection between the step-down switching regulator inductors and the output capacitors. Connect the GND side of the output capacitors directly to the thermal ground plane of the board.



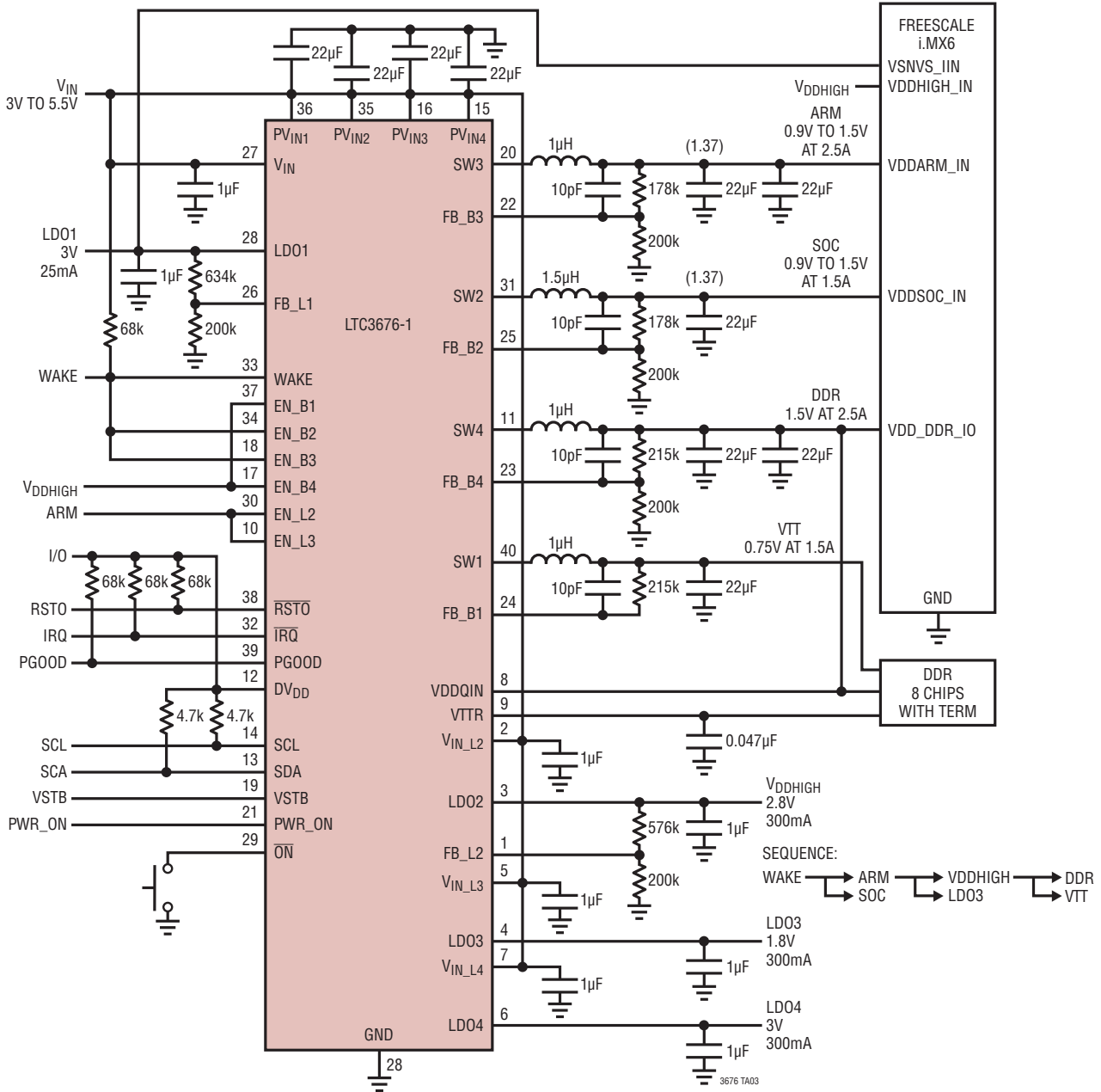
# TYPICAL APPLICATIONS

LTC3676 PMIC Configured to Support Freescale i.MX6 Processor



## TYPICAL APPLICATIONS

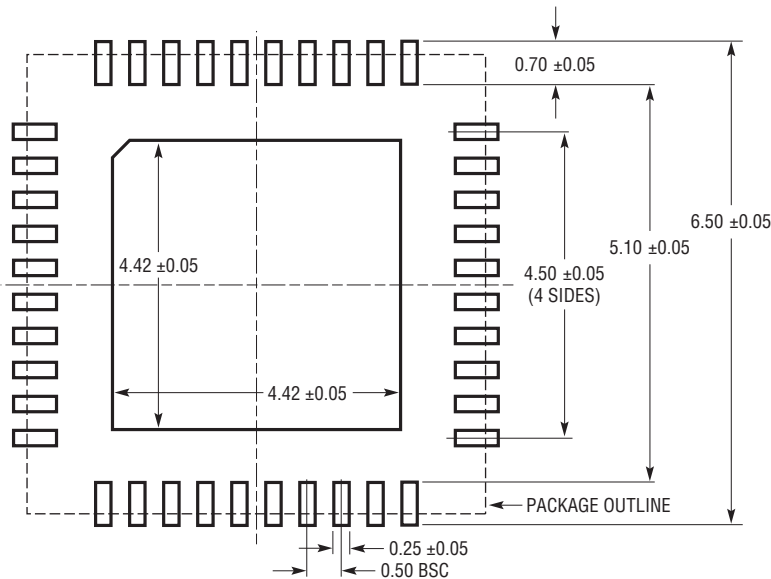
LTC3676-1 PMIC Configured to Support Freescale i.MX6 Processor with DDR V<sub>TT</sub> and V<sub>TRR</sub>



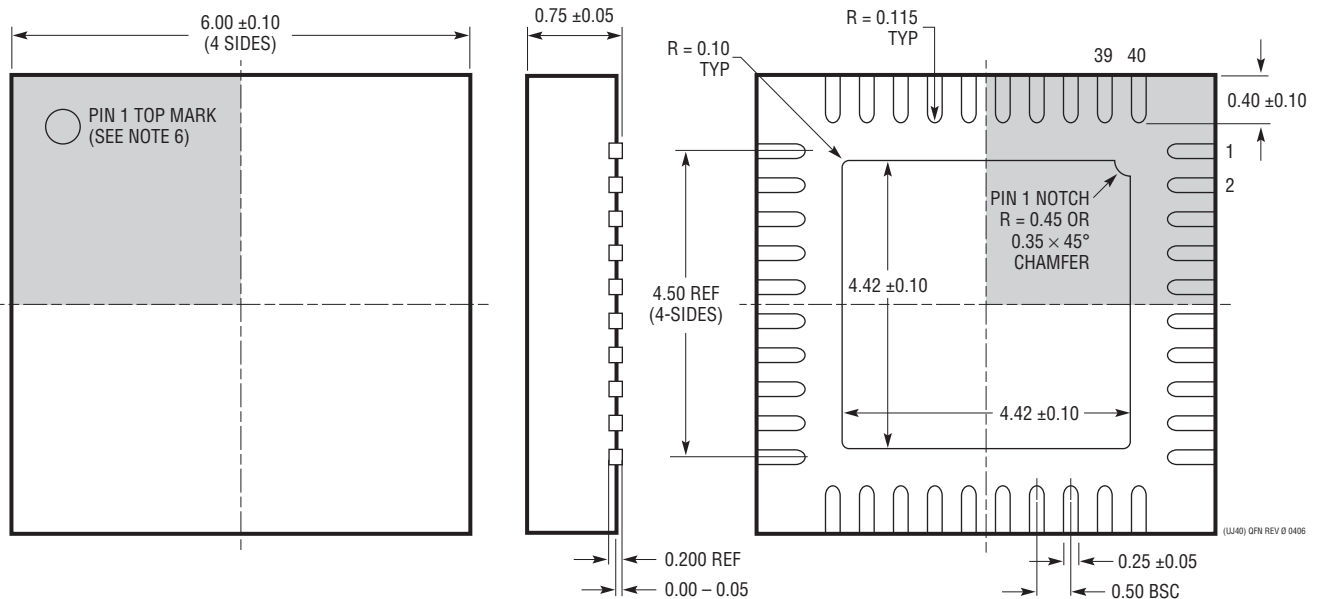
# PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

**UJ Package**  
**40-Lead Plastic QFN (6mm × 6mm)**  
 (Reference LTC DWG # 05-08-1728 Rev 0)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS  
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



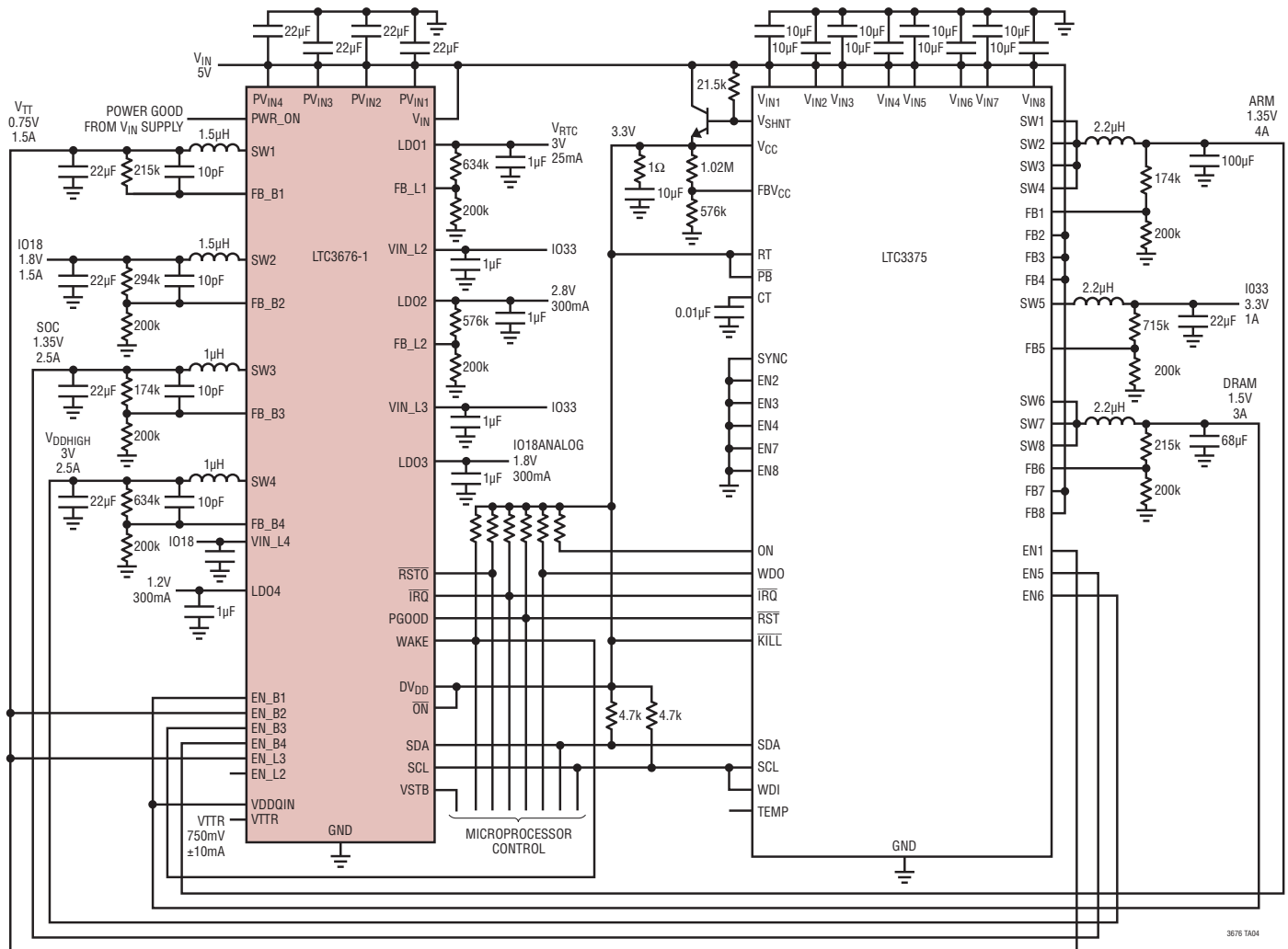
- NOTE:
1. DRAWING IS A JEDEC PACKAGE OUTLINE VARIATION OF (WJJD-2)
  2. DRAWING NOT TO SCALE
  3. ALL DIMENSIONS ARE IN MILLIMETERS
  4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.20mm ON ANY SIDE, IF PRESENT
  5. EXPOSED PAD SHALL BE SOLDER PLATED
  6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

BOTTOM VIEW—EXPOSED PAD

# LTC3676/LTC3676-1

## TYPICAL APPLICATION

### Sequenced Power for High Performance Processor and DDR Memory Using LTC3375 Parallelable Buck Converters



## RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
<a href="#">LTC3101</a>	1.8V to USB, Multioutput DC/DC Converter with Low Loss USB Power Controller	Seamless Transition Between Multiple Input Power Sources, $V_{IN}$ Range: 1.8V to 5.5V, Buck-Boost Converter $V_{OUT}$ Range: 1.5V to 5.25V, 3.3V $_{OUT}$ at 800mA for $V_{IN} \geq 3V$ , Dual 350mA Buck Regulators, $V_{OUT}$ : 0.6V to $V_{IN}$ , 38 $\mu$ A Quiescent Current in Burst Mode Operation, 24-Lead 4mm $\times$ 4mm $\times$ 0.75mm QFN Package
<a href="#">LTC3375</a>	8-Channel Programmable, Parallelable 1A Buck DC/DCs	8-Channel Independent Step-Down DC/DCs. Master Slave Configurable for Up to 4A per Output Channel with a Single Inductor, Die Temperature Monitor Output, 48-Lead 7mm $\times$ 7mm QFN Package
<a href="#">LTC3589/</a> <a href="#">LTC3589-1/</a> <a href="#">LTC3589-2</a>	8-Output Regulator with Sequencing and I <sup>2</sup> C	Triple I <sup>2</sup> C Adjustable High Efficiency Step-Down DC/DC Converters: 1.6A, 1A, 1A. High Efficiency 1.2A Buck-Boost DC/DC Converter. Triple 250mA LDO Regulators. Pushbutton ON/OFF Control with System Reset. Flexible Pin-Strap Sequencing Operation. I <sup>2</sup> C and Independent Enable Control Pins, DVS and Slew Rate Control, 40-Lead 6mm $\times$ 6mm $\times$ 0.75mm QFN Package
<a href="#">LTC3586/</a> <a href="#">LTC3586-1</a>	Switching USB Power Manager PMIC with Li-Ion/Polymer Charger	Complete Multifunction PMIC: Switching Power Manager, 1A Buck-Boost + 2 Bucks + Boost + LDO, 4mm $\times$ 6mm QFN-38 Package, LTC3586-1 Version Has 4.1V $V_{FLOAT}$ .